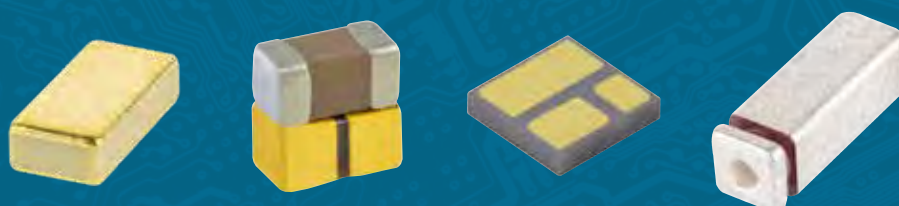
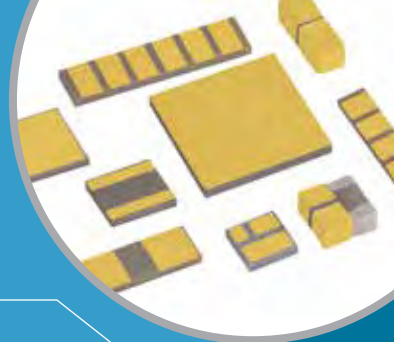


SLC Capacitors



Introduction to Knowles Precision Devices



Knowles Precision Devices is a premier global source for Capacitors, RF Filters, EMI Filters, Resonators, non-magnetic components and advanced dielectric materials.

An umbrella for the brands of Compex, DLI, Johanson MFG, Novacap, Syfer and Voltronics, Knowles Precision Devices serves a variety of markets including: military, aerospace/avionics, medical equipment, implantable devices, EMI and connector filtering, oil exploration, instrumentation, industrial electronics, automotive, telecoms and data networks.

	Trimmer	Multilayer	High Reliability Capacitors	Single Layer Capacitors	RF & Microwave Products
Capacitors: AEC-Q200		●	●		
Capacitors: Broadband Blocks		●	●		
Capacitors: Cap Assemblies		●	●		
Capacitors: Detonation Pulse		●	●		
Capacitors: High Power		●	●		
Capacitors: High Q		●	●		
Capacitors: High Temperature		●	●		
Capacitors: High Voltage		●	●		
Capacitors: MLC - Leaded		●			
Capacitors: MLC - SMD		●	●		
Capacitors: Non-Magnetic	●	●	●		
Capacitors: Non-Magnetic Leaded	●	●			
Capacitors: Non-Magnetic Trimmers	●	●	●		
Capacitors: Planars and Discoidals			●		
Capacitors: Safety Certified		●	●		
Capacitors: Single Layer			●	●	
Capacitors: Trimmers	●	●			
Dielectric Substrates				●	
EMI Filters		●	●		
Non-Magnetic Hardware	●				
Non-Magnetic Inductors	●				
Microwave Couplers					●
Microwave Filters					●
Microwave Power Dividers					●
Microwave Resonators					●
Microwave Tuning Elements	●				●
RF: Gain Equalizers					●
RF: Bias Filter Networks					●
RF: Self Bias Networks					●
Thin Film: Build To Print					●
Heatsink/Standoff				●	
Mounting Shorts				●	



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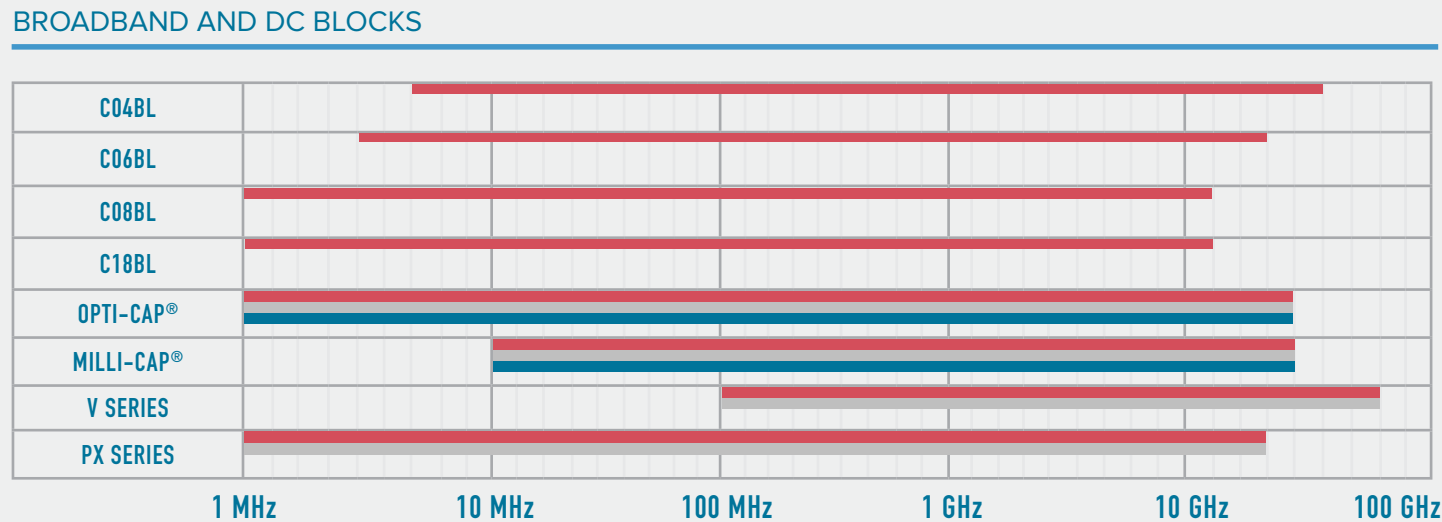
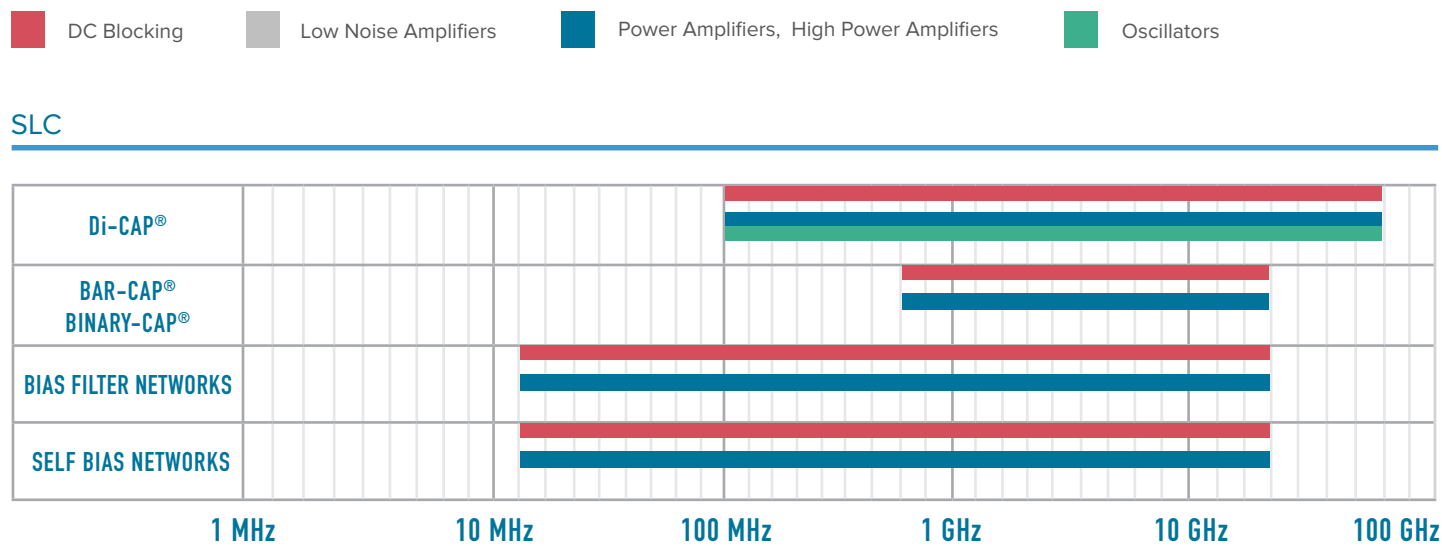
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Simplified Frequency & Product Application Chart



SLC – Dielectric Information

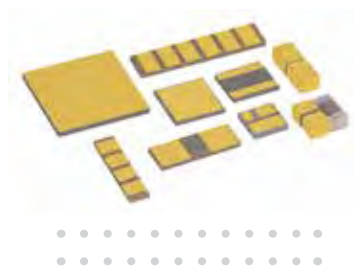
Single Layer Capacitors are available with any of our proprietary dielectric materials in the following configurations:

BORDER CAP®
Di-CAP®

BAR CAP®
Bi-CAP®

GAP CAP®
T-CAP®

Please consult the following pages for part number identification



DLI CLASS I DIELECTRIC MATERIALS

Dielectric Code	Relative ϵ_r @ 1 MHz	Temperature Coefficient -55°C to 125°C (ppm/°C Max)	1 MHz Dissipation Factor (% Maximum)	25°C Insulation Resistance (M Ω)	125°C Insulation Resistance (M Ω)
PI	9.9	P105 $\pm$ 20	0.15	>10 ⁶	>10 ⁵
PG	13	P22 $\pm$ 30	0.15	>10 ⁶	>10 ⁵
AH	20	P90 $\pm$ 20	0.15	>10 ⁶	>10 ⁵
CF	24	0 $\pm$ 15	0.60	>10 ⁶	>10 ⁵
NA	22	N30 $\pm$ 15	0.15	>10 ⁶	>10 ⁵
CD	37	N20 $\pm$ 15	0.15	>10 ⁶	>10 ⁵
NG	43	N220 $\pm$ 60	0.25	>10 ⁶	>10 ⁵
CG	70	0 $\pm$ 30	0.70	>10 ⁶	>10 ⁵
DB	72	N50 $\pm$ 30	0.15	>10 ⁶	>10 ⁵
NP	85	N750 $\pm$ 200	0.50	>10 ⁴	>10 ³
NR	160	N1500 $\pm$ 500	0.25	>10 ⁶	>10 ⁵
NS	300	N2400 $\pm$ 500	0.70	>10 ⁶	>10 ⁵
NU	600	N3700 $\pm$ 1000	1.50	>10 ⁶	>10 ⁵
NV	900	N4700 $\pm$ 1000	1.20	>10 ⁶	>10 ⁵

DLI CLASS II DIELECTRIC MATERIALS

Dielectric Code	Relative ϵ_r @ 1 MHz	Temperature Coefficient -55°C to 125°C (%)		1 MHz Dissipation Factor (% Maximum)	25°C Insulation Resistance (M Ω)	125°C Insulation Resistance (M Ω)
		No Bias, Pre Voltage Conditioning	No Bias, Post Voltage Conditioning			
BF*	445	$\pm$ 7.5	$\pm$ 10	2.5	>10 ⁴	>10 ²
BD	700	$\pm$ 10	$\pm$ 15	2.5	>10 ⁴	>10 ³
BG*	900	$\pm$ 10	$\pm$ 15	2.5	>10 ⁴	>10 ³
BC	1300	$\pm$ 10	$\pm$ 15	2.5	>10 ⁴	>10 ³
BE	1250	$\pm$ 10	$\pm$ 15	2.5	>10 ⁴	>10 ³
BL	2000	$\pm$ 15	$\pm$ 25	2.5	>10 ⁵	>10 ⁴
BJ	3300	$\pm$ 10	$\pm$ 15	3.0	>10 ⁵	>10 ⁴
BN	4500	$\pm$ 15	$\pm$ 25	3.0	>10 ⁵	>10 ⁴
UX	25,000 & 35,000	$\pm$ 15	$\pm$ 25	2.5	>10 ³	>10 ²

DLI CLASS III DIELECTRIC MATERIALS

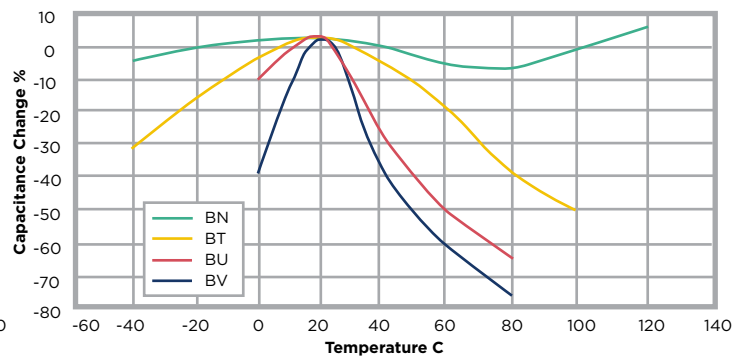
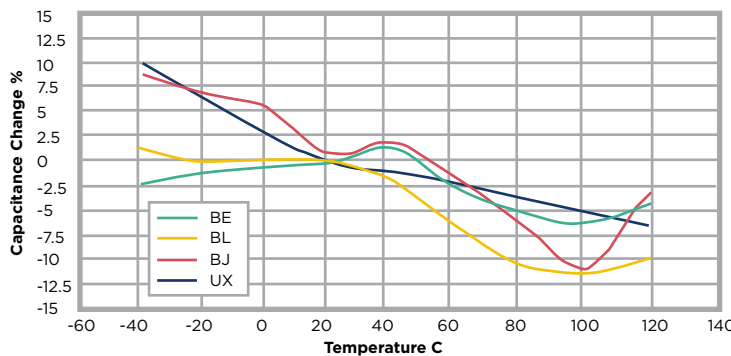
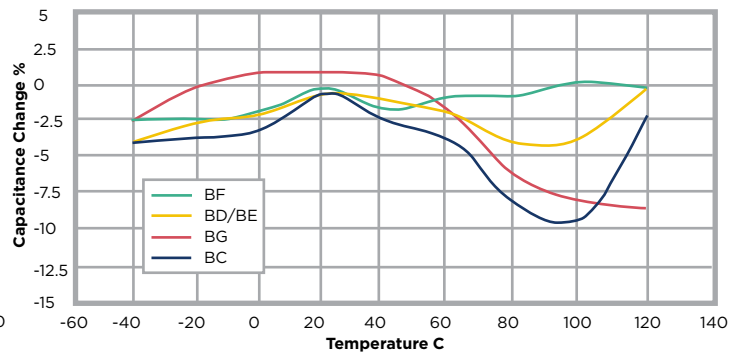
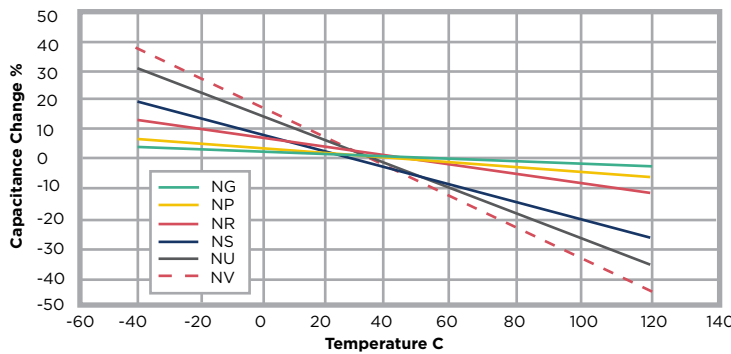
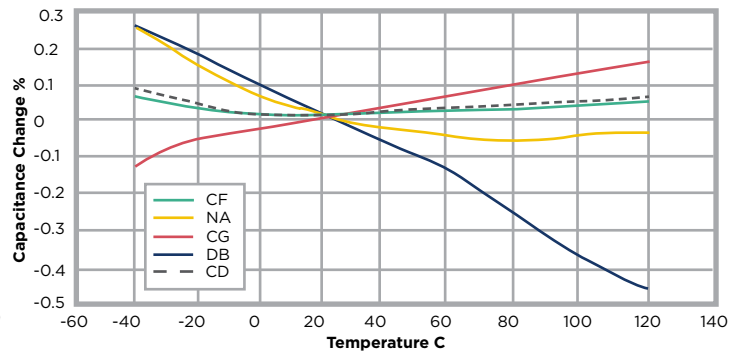
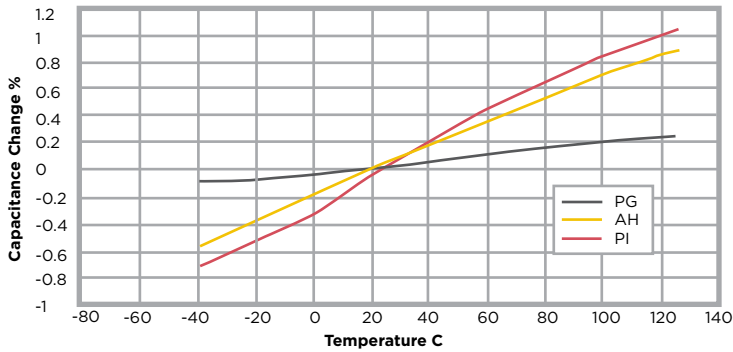
BT*	4200	+22, -56% (-55°C to 105°C)	+22, -56% (-55°C to 105°C)	3.0	>10 ⁵	>10 ²
BU	8500	+22, -82% (10°C to 85°C)	+22, -82% (10°C to 85°C)	3.0	>10 ⁵	>10 ⁴
BV	13,500	+22, -82% (10°C to 85°C)	+22, -82% (10°C to 85°C)	3.0	>10 ⁵	>10 ⁴

Note: * Recommended for commercial use only. Please contact an inside sales representative for additional information.

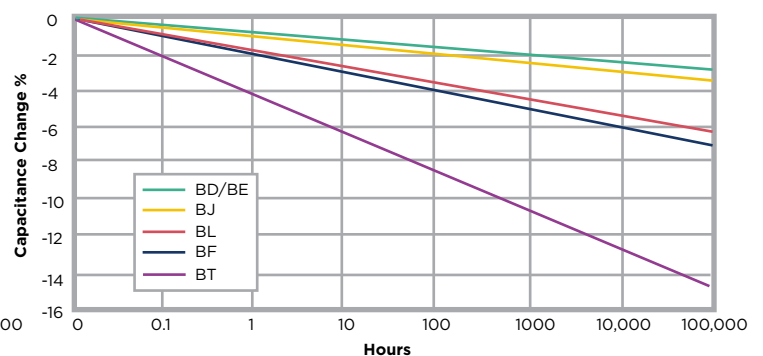
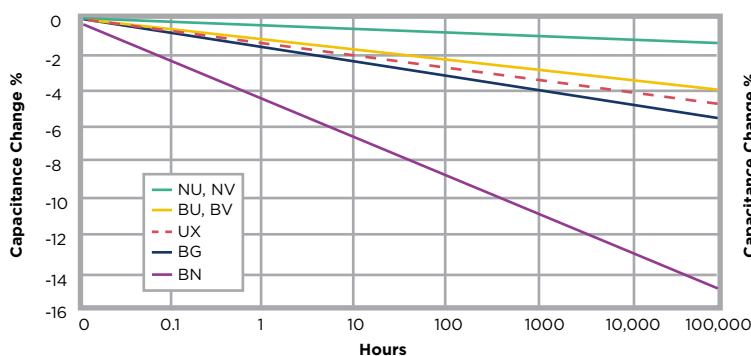


SLC – Dielectric Information

DIELECTRIC TEMPERATURE CHARACTERISTICS

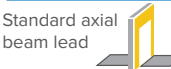


DIELECTRIC AGING CHARACTERISTICS



SLC – Specifications

TERMINATION CODES

Code		Description (Layers in order from dielectric material to outermost)		Capacitor Types
   	P	S1 (Sputter Plated) 1. 300 Angstroms Titanium-Tungsten 2. 50μ Inches min. Nickel-Vanadium 3. 100μ Inches min. Gold	AU-100 (Wet Plated) 1. 75μ Inches min. Nickel 2. 100μ Inches min. Gold	Di-Cap®, T-Cap®, Bar Cap®, Binary Cap® and Gap Cap®
	T	S2 1. 300 Angstroms Titanium-Tungsten 2. 50μ Inches min. Nickel-Vanadium 3. 100μ Inches min. Gold-Tin		Di-Cap® and T-Cap®
	M	S5 1. 300 Angstroms Titanium-Tungsten 2. 100μ Inches min. Gold		Di-Cap®, T-Cap®, Bar Cap®, Binary Cap® and Gap Cap®
	B	S1	AU-100	Single Border Cap
	E	S1	AU-100	Double Border Cap
Single beam lead 	L	Standard lead material is Silver (Ag) .002" thick. Optional Gold (Au). Lead length .250" min.		Di-Cap®
Axial beam lead 	A	Standard lead material is Silver (Ag) .002" thick. Optional Gold (Au). Lead length .250" min.		Di-Cap®
	Z	Standard lead material is Silver-Copper (Ag,Cu) .002" thick. Optional Gold (Au). Lead length .250" min.		
Standard axial beam lead 	S	Standard lead material is Silver (Ag) .002" thick. Optional Gold (Au). Lead length .250" min.		Di-Cap®

Consult with engineering for solderable metal stacks

TEST LEVEL CODES

Code	Description
Industrial/Commercial Options	
X	• 100% 4 Side Visual Screening • 1% AQL for the electrical parameters Capacitance, Dissipation Factor, Insulation Resistance and Dielectric Withstanding Voltage
Industrial/Commercial Options	
A	MIL-PRF-49464 Group A • 100% Thermal Shock • 100%, 100 +0/-4 Hours Voltage Conditioning • 100% Electrical Screening • 100% 6 Side Visual Screening • Bond Strength • Die Shear Strength • Temperature Coefficient Limits
B	MIL-PRF-49464 Group B • MIL-PRF-49464, Group A • Low Voltage Humidity • Immersion • Life
D	Special agreed upon testing to customers' formal specification. Customer Drawing Required! (May include, but is not limited to, one or more of the following common requests.) • 10(0) Destructive Bond Pull per MIL-STD-883, Method 2011. • 10(0) Die Shear per MIL-STD-883, Method 2019. Consult factory for other alternatives or assistance in specifying custom testing.
E	1% AQL Electrical (CAP/DF/IR/DWV) 100% 6 Sided Visual
H	MIL-PRF-38534 Class H
K	MIL-PRF-38534 Class K

CAPACITANCE TOLERANCE TABLE

Tolerance Code	Tolerance
P	±0.1pF
A	±0.05pF
B	±0.1pF
C	±0.25pF
D	±0.50pF
E	±5%
F	±1%
G	±2%
H	±3%
I	±4%
J	±5%
K	±10%
L	±15%
M	±20%
X	GMV
V	+100%, -0%
Z	+80%, -20%
S	Special

ENVIRONMENTAL & PHYSICAL TESTING PROCEDURES

Parameter	Method	MIL-STD-202 Condition
Thermal Shock	107	A, (modified), -55°C to +125°C
Immersion	104	B
Moisture Resistance	106	-
Resistance to Solder Heat	210	C, 260°C for 20 seconds
Life	108	A, 96 Hours @ +125°C.
Barometric Pressure	105	B
Shock, (Specified Pulse)	213	I, 100g's, 6ms.
Vibration, High Frequency	204	G, 30g's peak, 10Hz to 2kHz.

Parameter	Method	MIL-STD-202 Condition
Bond Strength	2011	D, 3 grams min. with .001 dia wire
Die Shear Strength	2019	Limit per MIL-STD-883, Figure 2019-4
Temperature Cycling	1010	C
Mechanical Shock	2002	B, Y1,
Constant Acceleration	2001	3,000g's Y1 direction

All Single Layer Capacitors are Lead Free (except Leaded Capacitors) and RoHS compliant.



SLC — Packaging

SLC WAFFLE PACKAGING

DLI offers a wide variety of standard design waffle packs in various materials depending on the application. Typical material offerings are antistatic and gel pack, which can contain up to 400 pieces depending on component dimension. Custom waffle packs are available; please consult the factory for details.

SLC TAPE AND REEL

DLI offers tape and reel packaging solutions for a variety of our single layer capacitor case sizes. Utilizing the latest technology and equipment to provide our customers the highest quality products, our standard SMD tape and reel packaging meets or exceeds EIA standards. Custom tape and reel packaging are available; consult the factory for options.

SLC ON TAPE RING

DLI offers single layer capacitors repopulated on blue membrane tape and photon ring assembly to maximize efficiency and minimize product cost. Used in high volume applications, the repopulated capacitors provide for more efficient component placement and fewer "pick and place" machine change-outs. The repopulated capacitors meet GMV capacitance value, are 100% visually acceptable and can be repopulated in custom shapes and sizes on a 6-inch photon tape ring.

SLC "BLACK DOTTED" ON TAPE RING

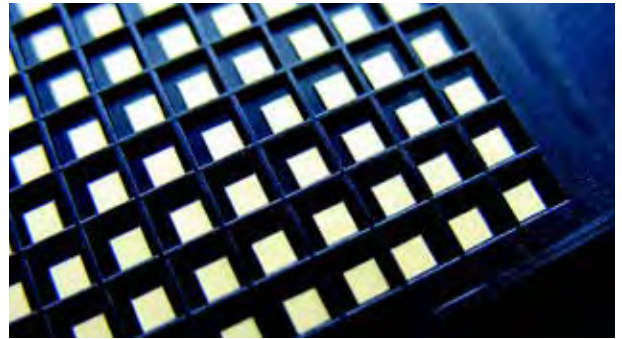
DLI offers "black dotted" capacitors on membrane tape and photon ring assembly. For high volume applications utilizing visual recognition, a less expensive alternative is the use of "black dotted" capacitors provided on saw dice membrane tape. The non- "black dotted" capacitors meet GMV capacitance value and a minimum of 75% visually acceptable product is guaranteed.

STORAGE

Single layer ceramic capacitors are solderable for a minimum of 1 year from date of shipment if properly stored in their original packaging. For extended periods, storage in a dry nitrogen environment is recommended. Product supplied on membrane tape and photon ring should be stored in the original container and in an environmentally controlled area where temperature and humidity are maintained. It is recommended not to store the product in direct light as this can negatively impact the adhesion properties of the tape.

HANDLING

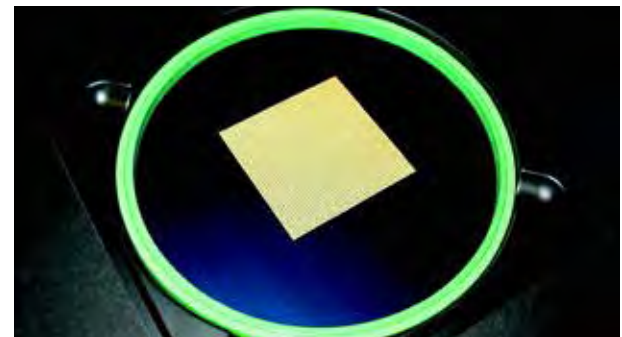
Single layer ceramic capacitors should be handled carefully during component transfer or placement, preventing damage to the gold and ceramic surfaces. The capacitors should be handled with precision stainless steel tweezers or a vacuum wand. Contacting the capacitor with bare hands should be avoided as resulting contaminants will affect the performance of the component.



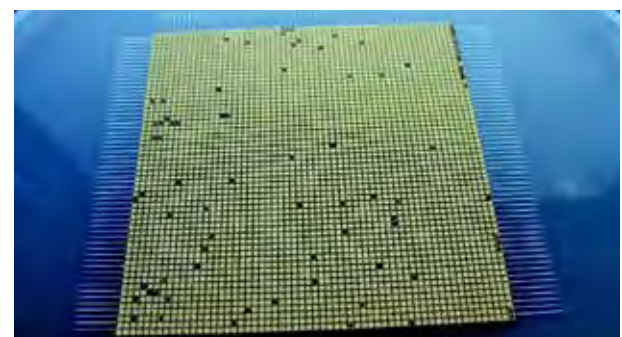
SLC Waffle Packaging



SLC Tape and Reel



SLC on Tape Ring



Black Dotted



SLC — Kits

All-in-One Engineer's Design Kit for SLCs

Reduce design time and make adjustments quickly

With the challenges of today's global supply chain, we understand that improving the efficiency of your development process is critical to delivering quality products on time.

You can streamline your design process and build prototypes quickly with our complete catalog of SLCs always at your disposal. Expediently perform analysis and lab testing on a wide range of SLCs, and evaluate form factor all with a simple trip to your part inventory.

Part Number to order kit: ENG DESIGN KIT SLC



Bypass Amplifier Kit

High Frequency Solutions

High frequency MMIC amplifiers with broadband gain need to be protected from RF noise on the supply lines, particularly RF energy coupled back into the device from its output. Utilize our Bypass Amplifier Kit to help select the correct capacitor for this type of application.

- Featuring our **Border Cap®** and **V-Series** capacitors

Part Number to order kit: AMPLIFIER BYPASS SAMPLE KIT



Visit knowlescapacitor.com to order your SLC Kit today!

SLC – V Series

DESCRIPTION

Class II dielectric material with X7R characteristics for DC Blocking or RF Bypass applications in a broad frequency range.

These high frequency, wire bondable single layer capacitors are perfect for GaN and GaAs amplifier applications where small size and microwave performance is key to a well-performing circuit.

- X7R Temperature Stability
- Excellent High Frequency Response
- Wire Bondable
- RoHS Compliant
- High Capacitance in a Small Footprint
- MSL-1
- Rated Operating/Storage Temp. -55 to +125°C



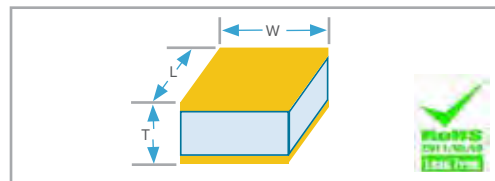
FUNCTIONAL APPLICATIONS

- DC Blocking
- RF Bypassing
- Filtering
- Tuning and Coupling

Part Number	Capacitance	Voltage	Dissipation Factor @ 1MHz	Insulation Resistance @ +25C	Insulation Resistance @ +125C
V30BZ102M6SX	1nF ± 20%	200WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ
V30BZ222M8SX	2.2nF ± 20%	150WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ
V30BZ472M1SX	4.7nF ± 20%	100WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ
V30BZ682M1SX	6.8nF ± 20%	100WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ
V30BZ103M1SX	10nF ± 20%	100WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ
V80BZ104M5SX	100nF ± 20%	50WVDC	2.5%	10 ⁹ MΩ	10 ² MΩ

Metal thickness is min. 100u" of Au over min. 50u" of Ni

Part Number	Length	Width	Thickness
V30BZ102M6SX	0.030" ± 0.003" (0.762mm ± 0.076mm)	0.030" ± 0.003" (0.762mm ± 0.076mm)	0.022" ± 0.003" (0.559mm ± 0.076mm)
V30BZ222M8SX			
V30BZ472M1SX			
V30BZ682M1SX			
V30BZ103M1SX			
V80BZ104M5SX	0.084" ± 0.004" (2.134" mm ± 0.102")	0.042" ± 0.004" (1.067" mm ± 0.102")	0.024" ± 0.003" (0.610" mm ± 0.076")



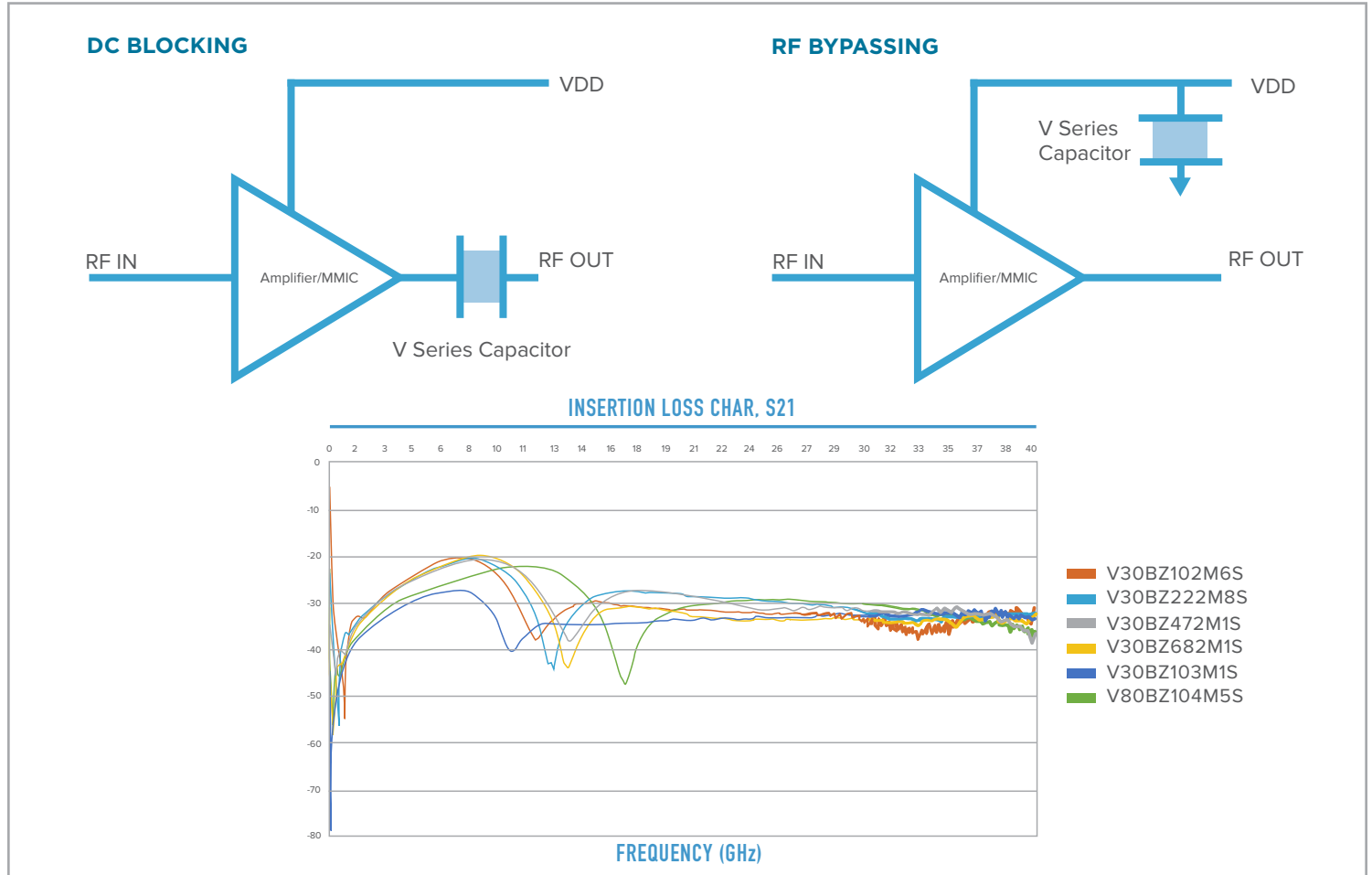
ORDERING INFORMATION – SLC – V SERIES CAPACITORS

V	30	BZ	102	M	5	S	X	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Packaging
V = V Series	30		102 = 1nF 222 = 2.2nF 472 = 4.7nF 682 = 6.8nF 103 = 10nF 104 = 100nF	M = ± 20%	5 = 50V 1 = 100V 8 = 150V 6 = 200V	S = Ni / Au	X = Commercial A = Group A B = Group B H = Class H K = Class K	Available in Waffle Packs.
	80		See test level definitions on page 7.					



SLC – V Series

PERFORMANCE CHARACTERISTICS – V SERIES CAPACITORS

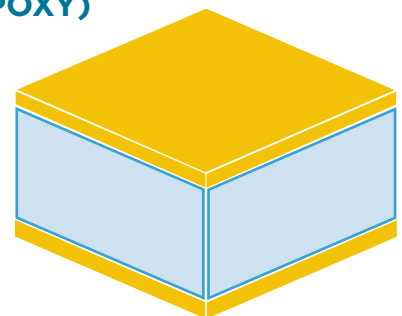


PERFORMANCE CHARACTERISTICS – V SERIES CAPACITORS

RECOMMENDED ATTACHMENT METHOD (CONDUCTIVE EPOXY) ALTERNATIVE ATTACHMENT METHOD (GOLD EUTECTIC)

Bonding can be done with either needle or automatic dispensers.

Epoxy curing defer to the epoxy manufacturer's preferred schedule but typically in the 125°C to 150°C range. Benefits of epoxy include easier repairs, cure doesn't need to be started immediately so multiple substrates may be processed at one time and epoxy is effective in higher frequencies.



Milli-Cap® — Ideal SMT Capacitor

FEATURES

- 0201, 0402 and 0602 Footprints
- Very Low Series Inductance
- Matches Typical 50Ω Line Widths
- Single-Piece Construction
- Low Loss High Q parts
- Ultra High Series Resonance
- Behaves Like an Ideal Capacitor
- Orientation Insensitive

FUNCTIONAL APPLICATIONS

- Test Equipment, Photonics, SONET, TOSA/ROSA, High-Speed Data
- Broadband Microwave/Millimeter Wave
- Transimpedance Amplifiers



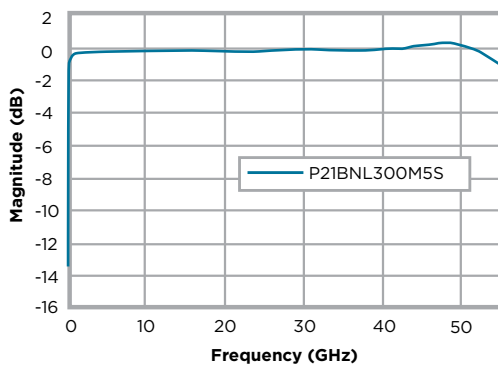
SPECIFICATIONS — MILLI-CAP®

Electrical

Temperature Coefficient of Capacitance	Electrical Characteristics Table
Milli-Cap® Metallization	7.5μ" Au over 50μ" Ni
Capacitance Range	0.5pF to 82pF
Maximum Assembly Process Temperature	250°C

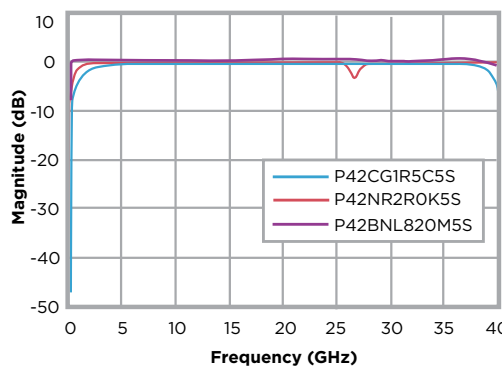
P21

Insertion Loss



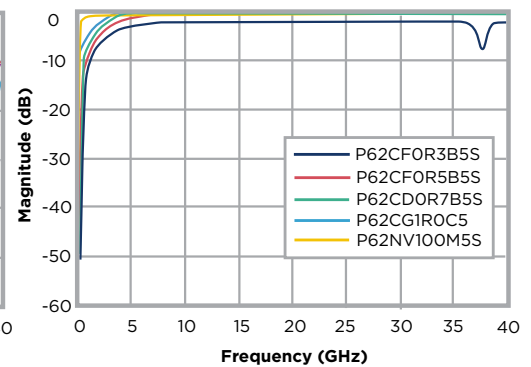
P42

Insertion Loss



P62

Insertion Loss



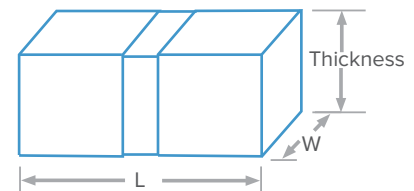
Milli-Cap® — Ideal SMT Capacitor

ELECTRICAL CHARACTERISTICS — MILLI-CAP®

Part Number	Value (pF)	Voltage Rating	TCC	Dissipation Factor (Max)	Insulation Resistance (Min)	Frequency Range
P21BNL300M5S	30	50	± 15%	3.5%	10 ⁵ MΩ	20MHz – 50GHz
P42BNL820M5S	82	50	± 15%	3.5%	10 ⁵ MΩ	20MHz – 50GHz
P42NR2R0K5S	2	50	N1500 ± 500ppm/°C	0.25%	10 ⁶ MΩ	4GHz – 20GHz
P42CG1R5C5S	1.5	50	0 ± 30ppm/°C	0.7%	10 ⁶ MΩ	8GHz – 32GHz
P62BNL820M5S	82	50	± 15%	3.5%	10 ⁵ MΩ	20MHz – 50GHz
P62NV100M5S	10	50	N4700 ± 1000ppm/°C	1.2%	10 ⁶ MΩ	4GHz – 20GHz
P62CG1R0C5S	1	50	0 ± 30ppm/°C	0.7%	10 ⁶ MΩ	18GHz – 40GHz
P62CD0R7B5S	0.7	50	N20 ± 15ppm/°C	0.15%	10 ⁶ MΩ	20GHz – 40GHz
P62CF0R5B5S	0.5	50	0 ± 15 ppm/°C	0.6%	10 ⁶ MΩ	28GHz – 40GHz

DIMENSIONAL SPECIFICATIONS — MILLI-CAP®

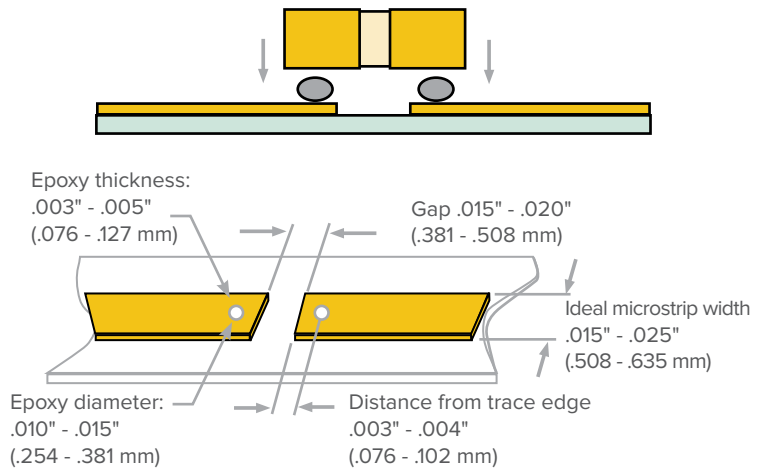
Case Size	Length	Milli-Cap® Width	Thickness
P21 (0201)	0.020" ± 0.004"	0.012" ± 0.002"	0.010" ± 0.002
P42 (0402)	0.038" ± 0.004"	0.020" ± 0.002"	0.020" ± 0.002"
P62 (0602)	0.058" ± 0.004"	0.020" ± 0.002"	0.020" ± 0.002"



ATTACHMENT METHODS — MILLI-CAP®

Recommended attachment to soft or hard substrate using Conductive Epoxy

1. Place a single drop of conductive epoxy onto each microstrip as illustrated; the edge of the epoxy shall be at least .003"-.004" back from the edge of the trace to prevent filling the gap with epoxy.
2. Centering the termination gap of the capacitor within the gap in the microstrip, press with careful, even pressure onto the microstrip ensuring the terminations make good contact with the epoxy drops.
3. Cure according to the epoxy manufacturer's preferred schedule, typically 125°C to 150°C max.
4. After curing, inspect joint for epoxy shorts across the termination and microstrip gaps that would cause a short across the cap.
5. Isopropanol and Methanol are both safe to use to pre-clean Milli-Caps®. Isopropanol and Methanol are not to be used after mounting with conductive epoxy as they act as a solvent.



Recommended attachment to soft or hard substrate using Solder

1. Place a single drop of solder paste onto each micro strip as illustrated; the edge of the solder shall be at least .001"-.002" back from the edge of the trace to prevent filling the gap with solder.
2. Centering the termination gap of the capacitor within the gap in the microstrip, press with careful, even pressure onto the microstrip ensuring the terminations make good contact with the drops of solder paste.
3. Reflow according to the solder manufacturer's preferred profile, ensuring the reflow temperature does not exceed 250°C.
4. After the reflow step is completed, inspect joint for voids or excess flux and non-reflowed solder balls that can degrade performance or cause shorts across the gaps. Proper cleaning after the reflow process is crucial to avoiding performance degradation and discovering poor solder joints. Isopropanol and Methanol are both safe to use with soldered Milli-Caps®.



Opti-Cap® – Ultra Broadband DC Blocking

FEATURES

- X7R temperature and voltage stability
- Resonance free DC blocking to >40GHz
- SMT by solder or epoxy bonding
- Low frequency stability over temperature
- Very low series inductance
- 0201, 0402 and 0602 footprints

FUNCTIONAL APPLICATIONS

- Test Equipment, Photonics, SONET, TOSA/ROSA, High-Speed Data
- Broadband Microwave/Millimeter Wave
- Transimpedance Amplifiers

BENEFITS

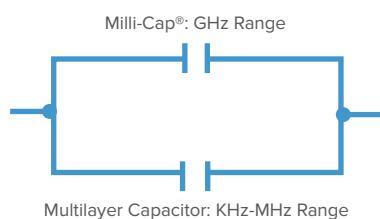
- Eliminates wire bonding
- Coplanar waveguide
- Low insertion loss



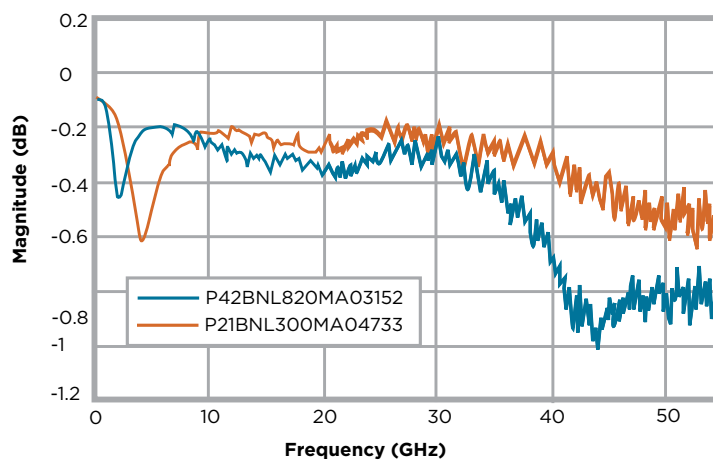
SPECIFICATIONS — OPTI-CAP®

Electrical

Temperature Coefficient of Capacitance	X5R: -55°C to +85°C (TCC ± 15%) X7R: -55°C to +125°C (TCC ± 15%)
Capacitance Range	1.5nF to 220nF
Maximum Assembly Process Temperature	250°C



INSERTION LOSS



ELECTRICAL CHARACTERISTICS — OPTI-CAP®

Part Number	MLC	Capacitance Milli-Cap®	Voltage Rating	TCC	DF (MAX)	IR (MIN)	Frequency Range
P21BNL300MA04733	100nF	30pF	10V	X5R	3.5%	>10 ² MΩ	16KHz - >40GHz
P21BNL300MA04282	22nF	30pF					
P21BNL300MA03976	10nF	30pF					
P21BNL300MA04678	1.5nF	30pF	25V	X7R			
P42BNL820MA03152	220nF	82pF	10V	X5R			
P42BNL820MA04679	22nF	82pF	50V	X7R			
P62BNL820MA02636	100nF	82pF	25V	X7R			



Opti-Cap® – Ultra Broadband DC Blocking

DIMENSIONAL SPECIFICATIONS – OPTI-CAP®

Case Size	Opti-Cap®			MLC		
	Length	Width	Thickness	Length	Width	Thickness
P21 (0201)	0.020" ± 0.004"	0.012" ± 0.002"	0.010" ± 0.002"	0.022" ± 0.002"	0.010" ± 0.001"	0.010" ± 0.002"
P42 (0402)	0.038" ± 0.004"	0.020" ± 0.002"	0.020" ± 0.002"	0.040" ± 0.002"	0.020" ± 0.002"	0.020" ± 0.002"
P62 (0602)	0.058" ± 0.004"	0.020" ± 0.002"	0.020" ± 0.002"	0.067" ± 0.004"	0.031" ± 0.004"	0.031" ± 0.005"

ATTACHMENT METHODS – OPTI-CAP®

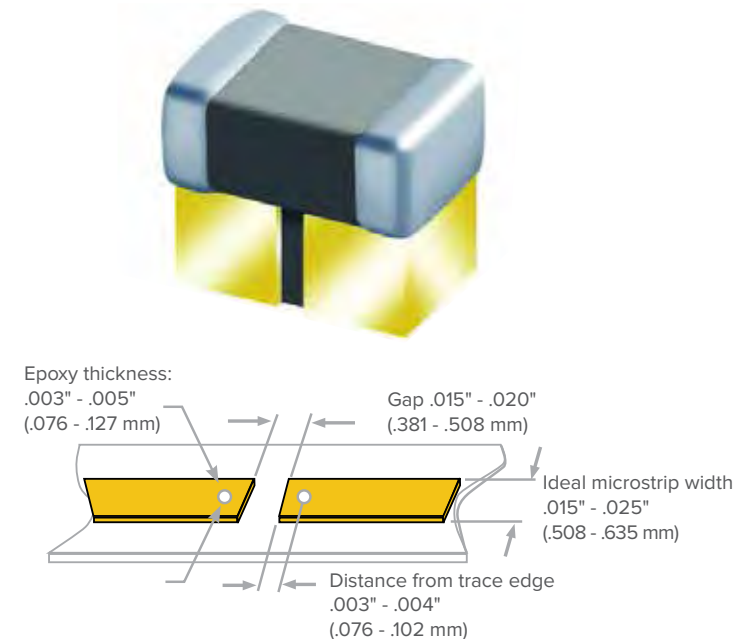
Recommended attachment to soft or hard substrate using Conductive Epoxy

1. Place a single drop of conductive epoxy onto each microstrip as illustrated; the edge of the epoxy shall be at least .003"-.004" back from the edge of the trace to prevent filling the gap with epoxy.
2. Centering the termination gap of the capacitor within the gap in the microstrip, press with careful, even pressure onto the microstrip ensuring the terminations make good contact with the epoxy drops.
3. Cure according to the epoxy manufacturer's preferred schedule, typically 125°C to 150°C max.
4. After curing, inspect joint for epoxy shorts across the termination and microstrip gaps that would cause a short across the cap.

Isopropanol and Methanol are both safe to use to pre-clean Opti-Caps®, Isopropanol, and Methanol are not to be used after mounting with conductive epoxy as they act as a solvent!

Recommended attachment to soft or hard substrate using Solder

1. Place a single drop of solder paste onto each microstrip as illustrated; the edge of the solder shall be at least .001"-.002" back from the edge of the trace to prevent filling the gap with solder.
2. Centering the termination gap of the capacitor within the gap in the microstrip, press with careful, even pressure onto the microstrip ensuring the terminations make good contact with the drops of solder paste.



3. Reflow according to the solder manufacturer's preferred profile, ensuring the reflow temperature does not exceed 250°C.
4. After the reflow step is completed, inspect joint for voids or excess flux and non-reflowed solder balls that can degrade performance or cause shorts across the gaps. Proper cleaning after the reflow process is crucial to avoiding performance degradation and discovering poor solder joints.

Isopropanol and Methanol are both safe to use with soldered Opti-Caps®.



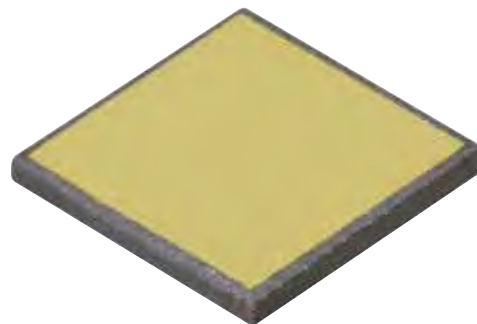
SLC – Border Cap®

DESCRIPTION

SLC with recessed metallization, available with borders on one or both sides.

Recessed metallization has been designed to minimize the potential of shorting during attachment (epoxy or solder).

- Available from 0.03pF to 2400pF
- Operating frequency up to 100GHz
- Wire Bondable
- 25, 50 and 100 Volt options
- Customized designs are available, please contact sales office



FUNCTIONAL APPLICATIONS

- DC Blocking
- Filtering
- RF Bypass
- Tuning and Coupling

TEST LEVEL CODES

Commercial Level

X	100% 4-Side Visual 1% AQL Electrical (CAP/DF/IR & DWV)
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HIGH RELIABILITY

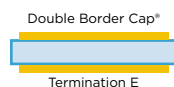
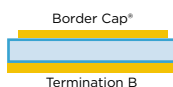
A	MIL-PRF-49464 Group A	B	MIL-PRF-49464 Group B
	• 100% Thermal Shock • 100% Voltage Conditioning • 100% Electrical (CAP/DF/IR & DWV) • 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient		• MIL-PRF-49464 Group A • Immersion • Low Voltage Humidity • Life
		D	• Customer Defined
		E	• 1% AQL Electrical (CAP/DF/IR/DWV) • 100% 6 Sided Visual
		H	MIL-PRF-38534 Class H
		K	MIL-PRF-38534 Class K

VOLTAGE

Code	Voltage
2	25 Volts
5	50 Volts
1	100 Volts

CONFIGURATION

Code	Description
B	Single-Sided
E	Double-Sided



TOLERANCE

Code	Description
P	$\pm 0.01\text{pF}$
A	$\pm 0.05\text{pF}$
B	$\pm 0.1\text{pF}$
C	$\pm 0.25\text{pF}$
D	$\pm 0.50\text{pF}$
K	$\pm 10\%$
L	$\pm 15\%$
M	$\pm 20\%$
X	GMV (Guarantee Minimum Value)
Z	+80%, -20%

ORDERING INFORMATION – SLC – BORDER CAP®

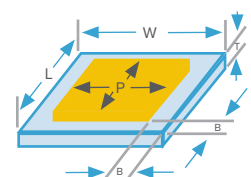
D	10	BJ	100	K	1	E	X	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Packaging
D = Border Cap®	10	See material tables on Page 5.	R03 = 0.03 pF	P = ± 0.01pF	2 = 25V* 5 = 50V 1 = 100V *For Capacitors with UX material only	B = Single Border E = Double Border	X	B = Black Dotted E = Repopulated T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.
	12		OR5 = 0.5 pF	A = ± 0.05pF			A	
	15		1R0 = 1.0 pF	B = ± 0.10pF			B	
	20		5R1 = 5.1 pF	C = ± 0.25pF			D	
	25		100 = 10 pF	D = ± 0.5pF			E	
	30		101 = 100 pF	K = ± 10%			H	
	35		152 = 1500 pF	L = ± 15%			K	
	40		Refer to Capacitance range tables for available values. Consult an inside sales rep for custom solutions.	M = ± 20% X = GMV Z = +80% -20%			See test level definitions on page 7.	
	50							



SLC – Border Cap®

DIMENSIONS

STYLE	LENGTH/WIDTH	PAD SIZE	BORDER	THICKNESS
D10	0.010" ± 0.001" (0.254mm ± 0.025mm)	0.008" (0.203mm)	0.001" (0.025mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D12	0.012" ± 0.001" (0.305mm ± 0.025mm)	0.010" (0.254mm)	0.001" (0.025mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D15	0.015" ± 0.001" (0.381mm ± 0.025mm)	0.011" (0.279mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D20	0.020" ± 0.001" (0.508mm ± 0.025mm)	0.016" (0.406mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D25	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.021" (0.533mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D30	0.030" ± 0.001" (0.762mm ± 0.025mm)	0.026" (0.660mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D35	0.035" ± 0.001" (0.889mm ± 0.025mm)	0.031" (0.787mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D40	0.040" ± 0.001" (1.016mm ± 0.025mm)	0.036" (0.914mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)
D50	0.050" ± 0.001" (1.27mm ± 0.025mm)	0.046" (1.168mm)	0.002" (0.051mm)	0.006" ± 0.0025" (0.152mm ± 0.064mm)



*UX material available in 25V (0.006" Thick) and 50V (0.010" Thick)

CAPACITANCE VALUES – SINGLE-SIDED

STYLE	D10			D12			D15			D20			D25			D30			D35			D40			D50		
CAPACITANCE (pF)																											
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.
PI	0.03	0.05	P	0.05	0.07	P	0.06	0.09	P	0.15	0.15	A	0.2	0.3	A	0.3	0.45	A	0.35	0.6	B	0.5	0.7	B	0.8	1.1	C
PG	0.04	0.06	P	0.06	0.09	P	0.08	0.1	P	0.15	0.2	A	0.25	0.4	A	0.35	0.55	B	0.5	0.8	B	0.65	0.95	B	1	1.5	C
AH	0.06	0.1	P	0.09	0.1	P	0.15	0.2	A	0.25	0.35	A	0.4	0.6	B	0.55	0.9	B	0.75	1.2	C	1	1.4	C	1.5	2.2	C
CF	0.07	0.1	P	0.1	0.15	A	0.15	0.2	A	0.25	0.45	A	0.45	0.7	B	0.65	1	B	0.8	1.3	C	1.1	1.6	C	1.7	2.4	C
NA	0.07	0.1	P	0.15	0.15	A	0.15	0.2	A	0.25	0.45	A	0.45	0.7	B	0.65	1	B	0.85	1.5	C	1.2	1.7	C	1.8	2.7	D
CD	0.15	0.15	A	0.2	0.25	A	0.25	0.35	A	0.45	0.7	B	0.7	1.1	C	0.95	1.6	C	1.4	2.2	C	1.8	2.7	D	2.7	4.3	D
CG	0.25	0.35	A	0.3	0.5	A	0.45	0.7	B	0.8	1.3	C	1.3	2	C	1.8	3	D	2.7	4.3	D	3.3	5.1	D	5.1	8.2	K
DB	0.25	0.35	A	0.35	0.5	A	0.45	0.7	B	0.8	1.3	C	1.3	2.2	C	1.9	3	D	2.7	4.3	D	3.6	5.1	D	5.6	8.2	K
NP	0.25	0.4	A	0.4	0.6	B	0.55	0.85	B	0.95	1.6	C	1.5	2.4	C	2.2	3.6	D	3	5.1	D	4.3	6.2	K	6.2	10	K
NR	0.5	0.8	B	0.7	1.1	C	1	1.6	C	1.8	3	D	3	4.7	D	4.3	6.8	K	6.2	10	K	7.5	11	K	12	18	K
NS	0.9	1.5	C	1.3	2.2	C	1.9	3	D	3.6	5.6	K	5.6	9.1	K	8.2	13	K	11	18	K	15	22	K	22	33	K
NU	1.8	3	D	2.7	4.3	D	3.9	5.6	K	6.8	11	K	11	18	K	16	27	K	22	36	K	30	43	K	47	68	K
NV	2.7	4.3	D	3.9	6.2	K	5.6	8.2	K	10	16	K	16	27	K	24	39	K	33	56	K	43	62	K	68	100	K
BD	2.2	3.3	K	3	5.1	K	4.3	6.8	K	8.2	13	K	13	20	K	18	30	K	27	43	K	33	51	K	51	82	K
BC	3.9	6.2	K	5.6	9.1	K	8.2	13	K	15	24	K	24	39	K	36	56	K	47	75	K	62	91	K	100	150	K
BE	3.6	6.2	K	5.6	9.1	K	8.2	12	K	15	22	K	24	36	K	33	56	K	47	75	K	62	91	K	91	130	K
BL	6.2	10	K,M	9.1	13	K,M	13	20	K,M	24	36	K,M	36	56	K,M	56	91	K,M	75	120	K,M	100	130	K,M	150	220	K,M
BJ	10	16	K	15	24	K	20	33	K	39	62	K	62	100	K	91	150	K	120	200	K	160	240	K	270	390	K
BN	13	22	K,M	20	33	K,M	30	43	K,M	51	82	K,M	82	130	K,M	120	200	K,M	160	270	K,M	220	330	K,M	330	510	K,M
BU	27	43	M	36	62	M	56	82	M	100	160	M	150	240	M	220	360	M	300	510	M	430	620	M	620	1000	M
BV	39	68	M	62	100	M	82	130	M	150	240	M	240	390	M	360	560	M	510	820	M	680	1000	M	1000	1500	M

UX MATERIAL CAPCITANCE TABLE (STANDARD M TOLERANCE)

STYLE	D10		D12		D15		D20		D25		D30		D35		D40		D50	
VOLTAGE	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
25V	82	100	120	140	160	200	300	370	490	590	710	860	1000	1200	1300	1600	2000	2400
50V	-	-	-	-	100	140	200	240	300	370	450	540	600	750	800	950	1300	1500



SLC – Border Cap®

CAPACITANCE VALUES – DOUBLE-SIDED

STYLE	D10			D12			D15			D20			D25			D30			D35			D40			D50		
CAPACITANCE (pF)																											
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.
PI	0.03	0.04	P	0.04	0.06	P	0.06	0.08	P	0.1	0.15	A	0.2	0.25	A	0.3	0.4	A	0.35	0.55	B	0.45	0.65	B	0.7	1.1	C
PG	0.04	0.06	P	0.06	0.08	P	0.07	0.1	P	0.15	0.2	A	0.25	0.35	A	0.35	0.5	A	0.5	0.7	B	0.6	0.9	B	0.95	1.4	C
AH	0.06	0.09	P	0.09	0.1	P	0.15	0.15	A	0.2	0.3	A	0.4	0.5	A	0.55	0.8	B	0.75	1.1	C	0.9	1.3	C	1.54	2.2	C
CF	0.07	0.1	P	0.1	0.15	A	0.15	0.15	A	0.25	0.35	A	0.45	0.65	B	0.65	0.95	B	0.8	1.3	C	1.1	1.6	C	1.7	2.4	C
NA	0.07	0.1	P	0.09	0.15	A	0.15	0.15	A	0.25	0.35	A	0.45	0.6	B	0.65	0.9	B	0.85	1.2	C	1	1.5	C	1.6	2.4	C
CD	0.15	0.15	A	0.15	0.25	A	0.2	0.3	A	0.4	0.6	B	0.7	1	B	0.95	1.5	C	1.4	2	C	1.7	2.4	C	2.7	3.9	D
CG	0.2	0.3	A	0.3	0.45	A	0.4	0.55	B	0.7	1.1	C	1.3	1.9	C	1.8	2.7	D	2.7	3.9	D	3.3	4.7	D	5.1	7.5	K
DB	0.25	0.35	A	0.35	0.5	A	0.5	0.7	B	0.9	1.3	C	1.3	2.1	C	1.9	3.1	D	2.7	4.3	D	3.6	5.6	K	5.6	9.1	K
NP	0.25	0.4	A	0.4	0.6	B	0.55	0.8	B	1	1.5	C	1.5	2.5	C	2.2	3.7	D	3	5.1	D	4.3	6.8	K	6.8	10	K
NR	0.45	0.7	B	0.65	1.1	C	0.85	1.3	C	1.6	2.4	C	3	4.3	D	4.3	6.2	K	6.2	9.1	K	7.5	11	K	12	16	K
NS	0.85	1.3	C	1.3	2	C	1.6	2.4	D	3	4.7	D	5.6	8.2	K	8.2	12	K	11	16	K	15	20	K	22	33	K
NU	1.7	2.7	D	2.7	3.9	D	3.3	4.7	K	6.2	9.1	K	11	16	K	16	24	K	22	33	K	27	39	K	43	62	K
NV	2.7	3.9	D	3.9	6.2	K	5.1	6.8	K	9.1	13	K	16	24	K	24	36	K	33	51	K	43	62	K	68	100	K
BD	2	3	K	3	4.7	K	3.9	5.6	K	7.5	11	K	12	18	K	18	27	K	24	39	K	33	47	K	51	75	K
BC	3.6	5.6	K	5.6	8.2	K	6.8	10	K	13	20	K	22	33	K	33	51	K	43	68	K	62	82	K	91	130	K
BE	3.6	6.2	K	5.1	8.2	K	6.8	10	K	13	20	K	22	33	K	30	51	K	43	68	K	56	82	K	91	130	K
BL	5.6	9.1	K,M	8.2	13	K,M	11	16	K,M	20	30	K,M	33	51	K,M	51	82	K,M	68	110	K,M	91	130	K,M	150	220	K,M
BJ	9.1	15	K	15	22	K	18	27	K	33	51	K	56	82	K	82	130	K	110	180	K	150	220	K	240	360	K
BN	13	20	K,M	20	30	K,M	24	36	K,M	47	68	K,M	75	120	K,M	110	180	K,M	150	240	K,M	200	300	K,M	330	470	K,M
BU	24	39	M	36	56	M	47	68	M	91	130	M	150	220	M	220	330	M	300	470	M	390	560	M	620	910	M
BV	39	62	M	56	91	M	75	110	M	150	220	M	220	360	M	330	510	M	470	750	M	620	910	M	1000	1500	M

UX MATERIAL CAPACITANCE TABLE (STANDARD M TOLERANCE)

STYLE	D10		D12		D15		D20		D25		D30		D35		D40		D50	
VOLTAGE	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
25V	75	91	110	130	140	170	270	320	440	540	650	800	900	1100	1200	1500	2000	2400
50V	-	-	-	-	91	110	170	210	280	340	410	500	560	700	750	900	1200	1500



SLC – T-Cap®

DESCRIPTION

High Performance Single Layer Capacitors for RF, Microwave and Millimeter Wave Applications.

- Wire Bondable: 100µ" Au with a Ni Barrier Layer
- Customized solutions available, please contact sales office

FUNCTIONAL APPLICATIONS

- DC Blocking
- RF Bypassing
- Filtering
- Tuning
- Insulation
- Submounts
- Stand-Offs

BENEFITS

- Dimensional consistency
- Gold metallization for wire bonding
- Rugged construction



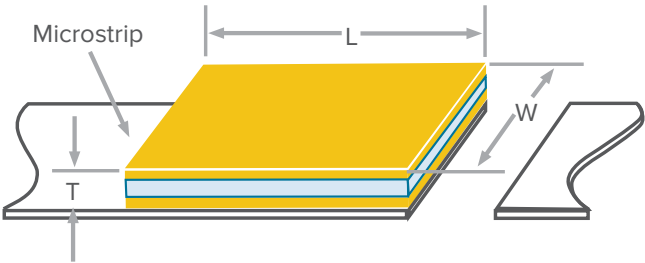
TEST LEVEL CODES

Commercial Level

X	100% 4-Side Visual
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HIGH RELIABILITY

A	MIL-PRF-49464 Group A • 100% Thermal Shock • 100% Voltage Conditioning • 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient	B	MIL-PRF-49464 Group B • MIL-PRF-49464 Group A • Immersion • Low Voltage Humidity • Life
		D	• Customer Defined
		E	• 6 Sided Visual
		H	MIL-PRF-38534 Class H
		K	MIL-PRF-38534 Class K



ORDERING INFORMATION – SLC – T-CAP®

T	30	BV	30	X	45	P	X	
Product	Width	Material	Length	Tolerance	Thickness	Termination	Test Level	Packaging
T = T-Cap®	Two digit number representing the Width in .001" For Widths >.099", Consult an inside sales rep.	See material tables on Page 5.	Two digit number representing the Length in .001" For Lengths >.099", Consult an inside sales rep.	X = Length & Width: ± .001", Thickness: .0005" S = Special	35 – 99 Represents thickness in .0001" K0 = .010" M0 = .020" Examples: 55 = .0055" K2 = .012" M5 = .025"	P = TiW/Ni/Au T = TiW/NiV/Au M = TiW/Au	X A B D E H K See test level definitions on page 7.	T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.



SLC – Di-Cap®

DESCRIPTION

High Performance Single Layer Capacitors for RF, Microwave and Millimeter Wave Applications.

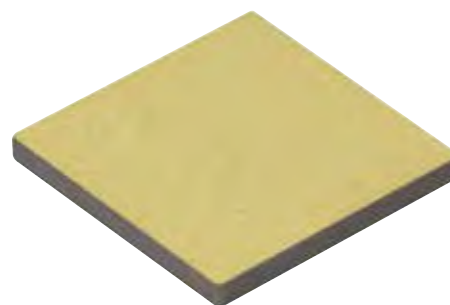
- Available from 0.03pF to 10,000pF
- Operating frequency up to 100GHz
- Wire Bondable
- Customized solutions are available, please contact sales office

FUNCTIONAL APPLICATIONS

- DC Blocking
- RF Bypassing
- Filtering
- Tuning and Coupling

BENEFITS

- ESD Proof
- Gold metallization for wire bonding
- Rugged construction



TEST LEVEL CODES

Commercial Level	
X	100% 4-Side Visual 1% AQL Electrical (CAP/DF/IR & DWV)

VOLTAGE

Code	Voltage
2	25 Volts
5	50 Volts
1	100 Volts

TOLERANCE

Code	Description
P	± 0.01pF
A	± 0.05pF
B	± 0.1pF
C	± 0.25pF
D	± 0.50pF
K	± 10%
L	± 15%
M	± 20%
X	GMV (Guarantee Minimum Value)
Z	+80%, -20%

HIGH RELIABILITY

A	MIL-PRF-49464 Group A	• 100% Thermal Shock • 100% Voltage Conditioning • 100% Electrical (CAP/DF/IR & DWV)	• 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient	B	MIL-PRF-49464 Group B
				D	• Customer Defined
				E	• 1% AQL Electrical (CAP/DF/IR/DMV) • 100% 6 Sided Visual
				H	MIL-PRF-38534 Class H
				K	MIL-PRF-38534 Class K

ORDERING INFORMATION – SLC – Di-CAP®

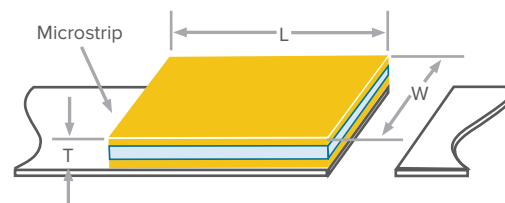
D	10	CF	OR1	A	5	P	X	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Packaging
D = Di-Cap®	10	See material tables on Page 5.	R03 = 0.03 pF	P = ± 0.01pF	2 = 25V* 5 = 50V 1 = 100V *For Capacitors with UX material only	P = Ni/Au or TiW/NiV/Au	X	T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.
	12		OR5 = 0.5 pF	A = ± 0.05pF		T = TiW/NiV/Au-Sn	A	
	15		1R0 = 1.0 pF	B = ± 0.10pF		M = TiW/Au	B	
	20		5R1 = 5.1 pF	C = ± 0.25pF		L = Single Beam Lead	D	
	25		100 = 10 pF	D = ± 0.5pF		A = Axial Beam Lead	E	
	30		101 = 100 pF	K = ± 10%		S = Standing Axial Beam Lead	H	
	35		432 = 4,300 pF	L = ± 15%		D = Special	K	
	50		Refer to Capacitance range tables for available values. Consult an inside sales rep. for custom solutions.	M = ± 20%		Z = Tin Copper Ribbon	See test level definitions on page 7.	
	70			X = GMV				
	90			Z = +80% -20%				



SLC — Di-Cap®

STYLE	LENGTH	WIDTH	THICKNESS	
			50 Volt	100 Volt
D10	0.010" MAX. (0.254mm MAX.)	0.010" + 0/-0.003" (0.254mm + 0/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	-
D12	0.015" MAX. (0.381mm MAX.)	0.012" + 0.002"/-0.003" (0.305mm + 0.051mm/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	-
D15	0.020" MAX. (0.508mm MAX.)	0.015" + 0/-0.003" (0.381mm + 0/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)
D20	0.020" MAX. (0.508mm MAX.)	0.020" + 0/-0.003" (0.508mm + 0/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)
D25	0.030" MAX. (0.762mm MAX.)	0.025" + 0/-0.003" (0.635mm + 0/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)
D30	0.030" MAX. (0.762mm MAX.)	0.030" + 0/-0.003" (0.762mm + 0/-0.076mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)
D35	0.040" MAX. (1.016mm MAX.)	0.035" ± 0.005" (0.889mm ± 0.127mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.007" ± 0.002" (0.178mm ± 0.051mm)
D40	0.050" MAX. (1.270mm MAX.)	0.040" +/- 0.005" (1.016mm +/- 0.127)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.007" ± 0.002" (0.178mm ± 0.051mm)
D50	0.060" MAX. (1.524mm MAX.)	0.050" ± 0.010" (1.270mm ± 0.254mm)	-	0.007" ± 0.002" (0.178mm ± 0.051mm)
D70	0.080" MAX. (1.778mm MAX.)	0.070" ± 0.010" (1.778mm ± 0.254mm)	-	0.007" ± 0.002" (0.178mm ± 0.051mm)
D90	0.100" MAX. (2.54mm MAX.)	0.090" ± 0.010" (2.286mm ± 0.254mm)	-	0.007" ± 0.002" (0.178mm ± 0.051mm)

*UX material available in 25V (0.006" Thick) and 50V (0.010" Thick)



CAPACITANCE VALUES — 50 VOLT RATED Di-CAP®

STYLE	D10			D12			D15			D20			D25			D30			D35			D40		
CAPACITANCE (pF)																								
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.
PI	0.03	0.05	P	0.04	0.1	P	0.06	0.15	A	0.09	0.2	A	0.2	0.4	A	0.25	0.45	A	0.35	0.85	B	0.36	1.6	C
PG	0.04	0.06	P	0.06	0.1	P	0.08	0.2	A	0.15	0.25	A	0.25	0.5	B	0.3	0.6	B	0.5	1.1	C	0.47	2	C
AH	0.06	0.1	P	0.08	0.2	A	0.15	0.3	A	0.2	0.4	A	0.35	0.8	B	0.45	0.95	B	0.7	1.8	C	0.72	3.2	D
CF	0.07	0.1	P	0.1	0.25	A	0.15	0.35	A	0.2	0.5	B	0.45	0.95	B	0.55	1.1	C	0.85	2	C	0.87	3.8	D
NA	0.06	0.1	P	0.09	0.2	A	0.15	0.3	A	0.2	0.45	B	0.4	0.9	B	0.5	1	B	0.8	1.9	C	0.79	3.5	D
CD	0.1	0.15	A	0.15	0.35	A	0.25	0.55	B	0.35	0.75	B	0.65	1.5	C	0.85	1.8	C	1.3	3.3	D	1.4	5.9	K
CG	0.2	0.35	A	0.3	0.75	B	0.45	1.1	C	0.65	1.4	C	1.2	2.7	C	1.6	3.3	D	2.7	6.2	K	2.5	11	K
DB	0.13	0.46	A	0.16	0.9	B	0.24	1.4	C	0.38	1.9	C	0.66	3.5	D	0.94	4.2	D	1.5	7.3	K	2.6	12	K
NP	0.25	0.4	A	0.35	0.9	B	0.5	1.3	C	0.75	1.8	C	1.5	3.3	D	1.9	3.9	D	3	7.5	K	3.1	14	K
NR	0.45	0.8	B	0.65	1.7	C	1	2.4	C	1.5	3.3	D	2.7	6.2	K	3.6	7.5	K	5.6	13	K	5.8	26	K
NS	0.8	1.5	C	1.2	3	D	1.8	4.7	D	2.7	6.2	K	5.1	12	K	6.8	13	K	11	27	K	10.9	48	K
NU	1.6	3	D	2.4	6.2	K	3.6	9.1	K	5.6	12	K	11	24	K	15	27	K	22	51	K	22	90	K
NV	2.4	4.3	D	3.6	9.1	K	5.6	13	K	8.2	18	K	16	36	K	20	43	K	33	75	K	32	140	K
BD	1.8	3.6	K	3	7.5	K	4.3	11	K	6.2	13	K	12	27	K	16	33	K	27	62	K	25	110	K
BC	3.6	6.2	K	5.1	13	K	7.5	20	K	12	27	K	22	51	K	30	62	K	47	110	K	47	200	K
BE	3.3	6.2	K	5.1	13	K	7.5	18	K	12	24	K	22	51	K	30	62	K	47	110	K	45	200	K
BL	5.6	10	K,M	8.2	20	K,M	12	30	K,M	24	39	K,M	36	82	K,M	47	91	K,M	75	180	K,M	72	320	K,M
BJ	9.1	16	K	13	33	K	20	51	K	30	68	K	56	130	K	75	160	K	120	270	K	115	530	K
BN	12	22	K,M	18	47	K,M	27	68	K,M	43	91	K,M	82	180	K,M	100	220	K,M	160	390	K,M	160	710	K,M
BU	22	43	M	36	91	M	51	130	M	75	180	M	150	330	M	200	390	M	300	750	M	330	1400	M
BV	36	68	M	56	130	M	82	200	M	120	270	M	240	510	M	300	620	M	510	1200	M	490	2100	M



SLC – Di-Cap®

CAPACITANCE VALUES – 100 VOLT RATED Di-CAP®

STYLE	D15			D20			D25			D30			D35			D50		
CAPACITANCE (pF)																		
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.
PI	0.04	0.1	P	0.06	0.1	P	0.15	0.25	A	0.15	0.3	A	0.2	0.55	B	0.5	1.3	C
PG	0.06	0.1	P	0.08	0.15	A	0.2	0.35	A	0.2	0.4	A	0.25	0.75	B	0.6	1.7	C
AH	0.08	0.2	A	0.15	0.25	A	0.25	0.5	B	0.35	0.65	B	0.4	1.2	C	0.95	2.7	D
CF	0.1	0.25	A	0.15	0.3	A	0.3	0.65	B	0.4	0.75	B	0.45	1.4	C	1.1	3	D
NA	0.09	0.2	A	0.15	0.3	A	0.3	0.5	B	0.35	0.7	B	0.45	1.3	C	1.1	3	D
CD	0.15	0.35	A	0.25	0.5	B	0.5	1	B	0.6	1.2	C	0.7	2.2	C	1.7	4.7	D
CG	0.3	0.7	B	0.45	0.95	B	0.95	1.9	C	1.1	2.2	C	1.3	3.9	D	3.3	9.1	K
DB	0.3	0.75	B	0.45	1	B	1	1.9	C	1.1	2.2	C	1.4	4.3	D	3.3	9.1	K
NP	0.35	0.85	B	0.55	1.2	C	1.2	2.2	C	1.3	2.7	D	1.6	5.1	D	3.9	11	K
NR	0.65	1.6	C	1	2.2	C	2.2	4.3	D	2.7	5.1	D	3	9.1	K	7.5	20	K
NS	1.2	3	D	1.9	3.9	D	3.9	8.2	K	4.7	9.1	K	5.6	18	K	15	39	K
NU	2.4	6.2	K	3.9	8.2	K	8.2	16	K	9.1	18	K	12	36	K	30	82	K
NV	3.6	9.1	K	5.6	12	K	12	24	K	15	27	K	18	51	K	43	120	K
BD	3	6.8	K	4.3	9	K	8	18	K	11	22	K	13	39	K	33	91	K
BC	5.6	13	K	8	18	K	16	33	K	20	43	K	24	75	K	62	160	K
BE	5.1	13	K	8	16	K	15	33	K	20	39	K	24	75	K	62	160	K
BL	8.2	20	K,M	13	27	K,M	24	51	K,M	33	62	K,M	39	120	K,M	100	270	K,M
BJ	13	33	K	20	47	K	38	82	K	51	100	K	62	180	K	160	430	K
BN	18	47	K,M	30	62	K,M	56	120	K,M	68	130	K,M	91	270	K,M	220	560	K,M
BU	36	82	M	56	120	M	100	220	M	130	270	M	160	510	M	390	1100	M
BV	56	130	M	82	180	M	160	360	M	220	430	M	270	750	M	620	1800	M

UX MATERIAL CAPCITANCE TABLE

STYLE	D10		D12		D15		D20		D25		D30		D35		D50		D70		D90	
CAPACITANCE (pF)																				
MATERIAL	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
25V	51	75	75	180	110	250	170	340	280	650	390	800	620	1400	1600	3200	3500	5900	6200	10,000
50V	-	-	-	-	-	-	100	200	170	390	240	470	360	850	940	2000	2100	3500	3700	5500



SLC – Bar Cap®

DESCRIPTION

Multiple Decoupling/Blocking Capacitors in a Single Array.

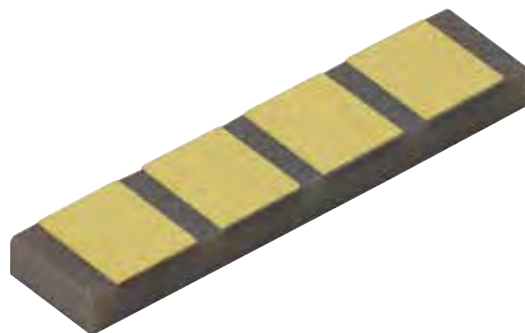
- Operating frequency up to 30GHz
- Wire Bondable: 100μ" Au with a Ni Barrier Layer
- Customized solutions available, please contact sales office

FUNCTIONAL APPLICATIONS

- DC Blocking
- RF Bypassing
- Decoupling
- GaAs ICs

BENEFITS

- Single insertion reduces complexity and cost
- Gold metallization for wire bonding
- Reduce bond wires for improved performance



TEST LEVEL CODES

Commercial Level

X	100% 4-Side Visual 1% AQL Electrical (CAP/DF/IR & DWV)
---	---

HIGH RELIABILITY

A	MIL-PRF-49464 Group A • 100% Thermal Shock • 100% Voltage Conditioning • 100% Electrical (CAP/DF/IR & DWV) • 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient	B	MIL-PRF-49464 Group B • MIL-PRF-49464 Group A • Immersion • Low Voltage Humidity • Life
		D	• Customer Defined
		E	• 1% AQL Electrical (CAP/DF/IR/DMV) • 100% 6 Sided Visual
		H	MIL-PRF-38534 Class H
		K	MIL-PRF-38534 Class K

TOLERANCE

Code	Description
Z	+80%, -20%

VOLTAGE

Code	Voltage
2	25 Volts
5	50 Volts
1	100 Volts

ORDERING INFORMATION – SLC – BAR CAP®

E	40	BU	151	Z	1	P	X	4	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Capacitor Quantity (mils)	Packaging
E = Bar Cap®	20 25 30 40	See material tables on Page 5.	800 = 80 pF 101 = 101 pF 121 = 120 pF 151 = 150 pF Consult an inside sales rep for custom solutions.	Z = +80% -20%	2 = 25V 5 = 50V 1 = 100V	P = TiW/NiV/Au M = TiW/Au	A B D H K X See test level definitions on page 7.	3 4 6 Etc.	T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.

*Custom Solutions are available; however, additional tooling costs may apply. Please contact the sales office for more information.

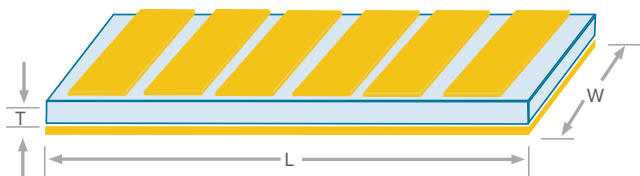
Capacitance is measured per pad.



SLC – Bar Cap®

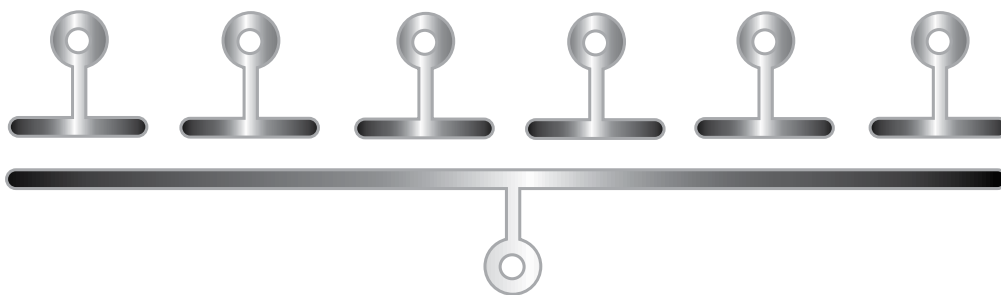
DIMENSIONS

Case Style	No. of Caps	Width	Length	Thickness	Pad Size
E20	3	0.020" ±0.003" (0.508mm ±0.076mm)	0.065" ±0.005" (1.651mm ±0.127mm)	See below	0.020" ±0.0015" (0.508mm ±0.381mm)
	4		0.085" ±0.005" (2.159mm ±0.127mm)		
	6		0.125" ±0.005" (3.175mm ±0.127mm)		
E25	3	0.025" ±0.003" (0.635mm ±0.076mm)	0.065" ±0.005" (1.651mm ±0.127mm)	See below	0.025" ±0.0015" (0.635mm ±0.381mm)
	4		0.085" ±0.005" (2.159mm ±0.127mm)		
	6		0.125" ±0.005" (3.175mm ±0.127mm)		
E30	3	0.030" ±0.003" (0.762mm ±0.076mm)	0.065" ±0.005" (1.651mm ±0.127mm)	See below	0.030" ±0.0015" (0.762mm ±0.381mm)
	4		0.085" ±0.005" (2.159mm ±0.127mm)		
	6		0.125" ±0.005" (3.175mm ±0.127mm)		
E40	3	0.040" ±0.003" (1.016mm ±0.076mm)	0.065" ±0.005" (1.651mm ±0.127mm)	See below	0.040" ±0.0015" (1.016mm ±0.381mm)
	4		0.085" ±0.005" (2.159mm ±0.127mm)		
	6		0.125" ±0.005" (3.175mm ±0.127mm)		



Voltage	Thickness
100 V	0.007" ± 0.001" (0.178mm ± 0.025mm)
25 V*	0.006" ± 0.001" (0.152mm ± 0.025mm)
50 V*	0.010" ± 0.001" (0.254mm ± 0.025mm)

*For UX Material Only



SLC – Gap Cap®

DESCRIPTION

Series Configured Capacitor for Microwave Applications. Recessed metallization has been designed to minimize the potential of shorting during attachment (epoxy or solder).

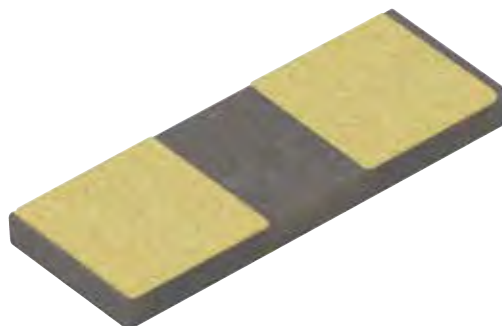
- Available from 0.2pF to 800pF
- Operating frequency up to 30GHz
- Customized solutions

FUNCTIONAL APPLICATIONS

- DC Blocking
- RF Bypassing
- Filtering
- Tuning
- Coupling

BENEFITS

- Eliminates wire bonding
- Coplanar waveguide
- Low insertion loss



TEST LEVEL CODES

Commercial Level

X	100% 4-Side Visual 1% AQL Electrical (CAP/DF/IR & DWV)
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HIGH RELIABILITY

A	MIL-PRF-49464 Group A • 100% Thermal Shock • 100% Voltage Conditioning • 100% Electrical (CAP/DF/IR & DWV) • 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient	B	MIL-PRF-49464 Group B • MIL-PRF-49464 Group A • Immersion • Low Voltage Humidity • Life
		D	• Customer Defined
		E	• 1% AQL Electrical (CAP/DF/IR/DMV) • 100% 6 Sided Visual
		H	MIL-PRF-38534 Class H
		K	MIL-PRF-38534 Class K

TOLERANCE

Code	Description
A	± 0.05pF
B	± 0.1pF
C	± 0.25pF
D	± 0.50pF
K	± 10%
L	± 15%
M	± 20%
X	GMV (Guarantee Minimum Value)
Z	+80%, -20%

VOLTAGE

Code	Voltage
2	25 Volts
5	50 Volts

ORDERING INFORMATION – SLC – GAP CAP®

G	10	BU	100	K	5	P	X	05	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Gap Width (mils)	Packaging
G = Gap-Cap®	10 15 20 25 30 35 50	See material tables on Page 5.	R01 = 0.01 pF OR5 = 0.5 pF 1R0 = 1.0 pF 5R1 = 5.1 pF 100 = 10 pF 511 = 510 pF Refer to Capacitance range tables for available values. Consult an inside sales rep for custom solutions.	A = ±0.05pF B = ±0.10pF C = ±0.25pF D = ±0.5pF K = ±10% L = ±15% M = ±20% X = GMV Z = +80% -20%	2 = 25V 5 = 50V	P = TiW/NiV/Au M=TiW/Au	X A B D E H K See test level definitions on page 7.	05 08 10 15	T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.



SLC – Gap Cap®

DIMENSIONS – 25 VOLT GAP CAP®

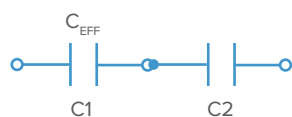
Style	Gap (Nominal)	Width	Length	Thickness
G10	0.005" (0.127mm)	0.010" + 0/-0.003" (0.254mm + 0/-0.076mm)	0.030" MAX. (0.762mm MAX.)	0.004" ± 0.001" (0.102mm ± 0.025mm)
G15	0.008" (0.203mm)	0.015" + 0/-0.003" (0.381mm + 0/-0.076mm)	0.040" MAX. (1.016mm MAX.)	
G20	0.010" (0.254mm)	0.020" + 0/-0.003" (0.508mm + 0/-0.076mm)	0.050" MAX. (1.270mm MAX.)	
G25	0.020" (0.508mm)	0.025" + 0/-0.003" (0.635mm + 0/-0.076mm)	0.060" MAX. (1.524mm MAX.)	
G30		0.030" + 0/-0.003" (0.762mm + 0/-0.076mm)		
G35		0.035" ± 0.005" (0.889mm ± 0.127mm)		
G50		0.050" ± 0.010" (1.27mm ± 0.254mm)	0.080" MAX. (2.032mm MAX.)	0.006" ± 0.001" (0.152mm ± 0.025mm)

*UX thickness 0.006" (0.152mm)

DIMENSIONS – 50 VOLT GAP CAP®

Style	Gap (Nominal)	Width	Length	Thickness
G10	0.005" (0.127mm)	0.010" + 0/-0.003" (0.254mm + 0/-0.076mm)	0.030" MAX. (0.762mm MAX.)	0.006" ± 0.001" (0.152mm ± 0.025mm)
G15	0.008" (0.203mm)	0.015" + 0/-0.003" (0.381mm + 0/-0.076mm)	0.040" MAX. (1.016mm MAX.)	
G20	0.010" (0.254mm)	0.020" + 0/-0.003" (0.508mm + 0/-0.076mm)	0.050" MAX. (1.270mm MAX.)	
G25	0.020" (0.508mm)	0.025" + 0/-0.003" (0.635mm + 0/-0.076mm)	0.080" MAX. (2.032mm MAX.)	
G30		0.030" + 0/-0.003" (0.762mm + 0/-0.076mm)		
G35		0.035" ± 0.005" (0.889mm ± 0.127mm)		
G50		0.050" ± 0.010" (1.27mm ± 0.254mm)		

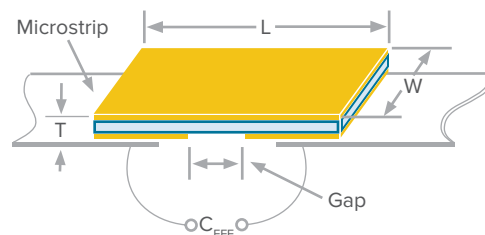
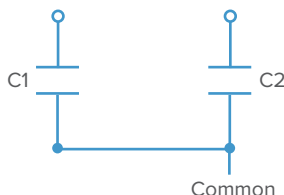
*UX thickness 0.010" (0.254mm)



$$C_{EFF} = \text{SERIES EQUIVALENT}$$

$$C1 = C2 \quad C_{EFF} = C1 \div 2$$

ALL GAP CAP VALUES ARE LISTED AS C_{EFF}



SLC – Gap Cap®

CAPACITANCE VALUES – 25 VOLT RATED GAP CAP®

STYLE	G10			G15			G20			G25			G30			G35			G50			
CAPACITANCE (pF)																						
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	
PI	0.02	0.03	A	0.03	0.07	A	0.04	0.10	A	0.05	0.15	A	0.06	0.15	A	0.07	0.20	A	-	-	-	
PG	0.02	0.05	A	0.04	0.10	A	0.05	0.15	A	0.07	0.20	A	0.08	0.25	A	0.09	0.25	A	-	-	-	
AH	0.04	0.08	A	0.06	0.15	A	0.08	0.25	A	0.10	0.30	A	0.15	0.35	A	0.15	0.45	A	-	-	-	
CF	0.04	0.09	A	0.08	0.15	A	0.10	0.30	A	0.15	0.35	A	0.15	0.45	A	0.20	0.50	A	-	-	-	
NA	0.04	0.08	A	0.07	0.15	A	0.09	0.25	A	0.15	0.35	A	0.15	0.40	A	0.15	0.50	A	-	-	-	
CD	0.06	0.10	A	0.15	0.25	A	0.15	0.45	A	0.20	0.60	B	0.25	0.70	B	0.30	0.80	B	-	-	-	
CG	0.15	0.25	A	0.25	0.50	A	0.30	0.90	B	0.35	1.1	B	0.45	1.3	C	0.50	1.6	C	-	-	-	
DB	0.15	0.25	A	0.25	0.55	B	0.30	0.90	B	0.35	1.1	B	0.45	1.4	C	0.50	1.6	C	-	-	-	
NP	0.15	0.30	A	0.30	0.65	B	0.35	1.1	C	0.40	1.3	C	0.55	1.6	C	0.60	1.9	C	-	-	-	
NR	0.25	0.60	A,B	0.50	1.2	B	0.65	2.0	C	0.75	2.4	C	0.95	3.0	D	1.1	3.6	D	-	-	-	
NS	0.50	1.2	B	0.90	2.2	C,K	1.2	3.9	D,K	1.4	4.7	D,K	1.8	5.6	D,K	2.2	6.8	K	-	-	-	
NU	0.95	2.4	C,K	1.8	4.3	C,K	2.4	7.5	D,K	3.0	9.1	D,K	3.6	11	K	4.3	13	K	-	-	-	
NV	1.4	3.6	C,K	2.7	6.8	D,K	3.6	11	D,K	4.3	13	K	5.6	16	K	6.2	20	K	-	-	-	
BD	1.1	2.7	K	2.2	5.1	K	2.7	9.1	K	3.3	11	K	4.3	13	K	5.1	16	K	-	-	-	
BC	2.0	5.1	K	3.9	10	K	5.1	16	K	6.2	20	K	8.2	24	K	9.1	27	K	-	-	-	
BE	2.0	4.7	K	3.9	9.1	K	5.1	16	K	6.2	20	K	7.5	24	K	9.1	27	K	-	-	-	
BL	3.3	7.5	K	6.2	15	K	8.2	24	K	10	30	K	12	39	K	15	43	K	-	-	-	
BJ	5.1	13	K	10	24	K	13	43	K	16	51	K	20	62	K	24	75	K	-	-	-	
BN	7.5	18	K	15	33	K	18	56	K	22	68	K	27	82	K	33	100	K	-	-	-	
BU	15	33	K,M	27	62	K,M	33	110	K,M	43	130	K,M	51	160	K,M	62	180	K,M	-	-	-	
BV	22	51	M	43	100	M	51	160	M	68	200	M	82	240	M	100	300	M	-	-	-	
UX	40	60	M	90	120	M	150	200	M	190	250	M	265	300	M	310	350	M	500	800	M	

CAPACITANCE VALUES – 50 VOLT RATED GAP CAP®

STYLE	G10			G15			G20			G25			G30			G35			G50		
CAPACITANCE (pF)																					
MATERIAL	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.	MIN.	MAX.	TOL.
PI	0.02	0.02	A	0.03	0.05	A	0.03	0.08	A	0.04	0.15	A	0.05	0.15	A	0.06	0.20	A	0.07	0.35	A
PG	0.02	0.03	A	0.03	0.06	A	0.04	0.10	A	0.05	0.20	A	0.07	0.25	A	0.07	0.25	A	0.09	0.50	A
AH	0.03	0.05	A	0.05	0.10	A	0.06	0.15	A	0.08	0.30	A	0.10	0.35	A	0.15	0.45	A	0.15	0.75	A,B
CF	0.03	0.06	A	0.06	0.10	A	0.07	0.20	A	0.09	0.35	A	0.15	0.45	A	0.15	0.50	A	0.20	0.90	A,B
NA	0.03	0.05	A	0.05	0.10	A	0.07	0.15	A	0.08	0.35	A	0.15	0.40	A	0.15	0.45	A	0.20	0.85	A,B
CD	0.04	0.09	A	0.08	0.15	A	0.15	0.30	A	0.15	0.55	A	0.20	0.70	A,B	0.20	0.80	A,B	0.30	1.4	A,B
CG	0.08	0.15	A	0.15	0.35	A	0.20	0.60	A	0.30	1.1	A	0.35	1.3	A,B	0.40	1.5	A,B	0.50	2.7	A,B
DB	0.08	0.15	A	0.20	0.35	A	0.25	0.60	A	0.30	1.1	A,B	0.35	1.3	B,C	0.40	1.6	B,C	0.50	2.7	B,C
NP	0.09	0.20	A	0.20	0.40	A	0.25	0.70	B	0.35	1.3	B	0.40	1.6	B,C	0.50	1.9	B,C	0.60	3.3	B,C
NR	0.20	0.40	A	0.35	0.80	B	0.45	1.3	B,C	0.60	2.4	B,C	0.75	3.0	D	0.90	3.6	D	1.2	6.2	D,K
NS	0.35	0.8	C,K	0.65	1.5	C,K	0.85	2.4	C,K	1.1	4.7	C	1.4	5.6	D,K	1.6	6.2	D,K	2.2	11	D,K
NU	0.65	1.6	C,K	1.3	3.0	C,K	1.7	5.1	D,K	2.2	9.1	D,K	3.0	11	K	3.3	13	K	4.3	22	K
NV	0.95	2.4	C,K	2.0	4.7	C,K	2.7	7.5	D,K	3.3	13	D,K	4.3	16	K	5.1	20	K	6.2	33	K
BD	0.75	1.8	K	1.5	3.6	K	2.0	5.6	K	2.7	11	K	3.3	13	K	3.9	15	K	5.1	27	K
BC	2.0	4.6	K	3.8	8.5	K	3.5	13.8	K	5.3	25	K	6.4	30	K	7.4	35	K	26	50	K
BE	2.0	4.6	K	3.8	8.5	K	3.5	13.8	K	5.3	25	K	6.4	30	K	7.4	35	K	26	50	K
BL	2.2	5.1	K	4.3	10	K	6.2	16	K	7.5	30	K	10	36	K	11	43	K	15	75	K
BJ	3.6	8.2	K	7.5	16	K	10	27	K	12	51	K	16	62	K	18	68	K	24	120	K
BN	5.1	12	K	10	22	K	13	39	K	18	68	K	22	82	K	24	100	K	33	160	K
BU	9.1	22	M	20	43	M	24	68	M	33	130	M	43	160	M	47	180	M	62	330	M
BV	15	36	M	30	68	M	39	110	M	51	200	M	68	240	M	75	300	M	100	510	M
UX	-	-	-	60	70	M	90	120	M	140	160	M	180	190	M	200	250	M	380	550	M

SLC — Bi-Cap®

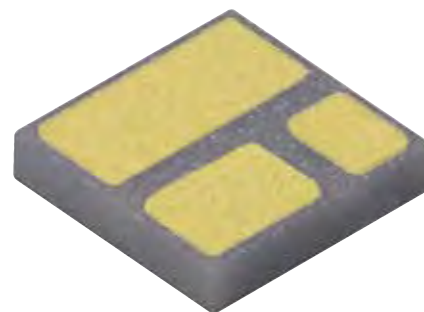
Binary Tunable Caps for Single-Layer Hybrids.

FUNCTIONAL APPLICATIONS

- Matching Networks
- Tank Circuits
- Tuning
- Coupling

BENEFITS

- Small size compatible with microwave geometries
- Hybrid Circuits — engineering designs
- Operating frequency up to 30GHz
- Customized solutions



TEST LEVEL CODES

Commercial Level

X	100% 4-Side Visual 1% AQL Electrical (CAP/DF/IR & DWV)
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HIGH RELIABILITY

A	MIL-PRF-49464 Group A • 100% Thermal Shock • 100% Voltage Conditioning • 100% Electrical (CAP/DF/IR & DWV) • 100% 6-Side Visual • Bond Strength • Die Shear • Temperature Coefficient	B	MIL-PRF-49464 Group B • MIL-PRF-49464 Group A • Immersion • Low Voltage Humidity • Life
		D	• Customer Defined
		E	• 1% AQL Electrical (CAP/DF/IR/DMV) • 100% 6 Sided Visual
		H	MIL-PRF-38534 Class H
		K	MIL-PRF-38534 Class K

TOLERANCE

Code	Description
A	$\pm 0.05\text{pF}$
B	$\pm 0.10\text{pF}$
C	$\pm 0.25\text{pF}$
D	$\pm 0.50\text{pF}$
K	$\pm 10\%$
L	$\pm 15\%$
M	$\pm 20\%$
X	GMV (Guarantee Minimum Value)
Z	+80%, -20%

VOLTAGE

Code	Voltage
2	25 Volts
5	50 Volts
1	100 Volts

ORDERING INFORMATION — SLC — Bi-CAP®

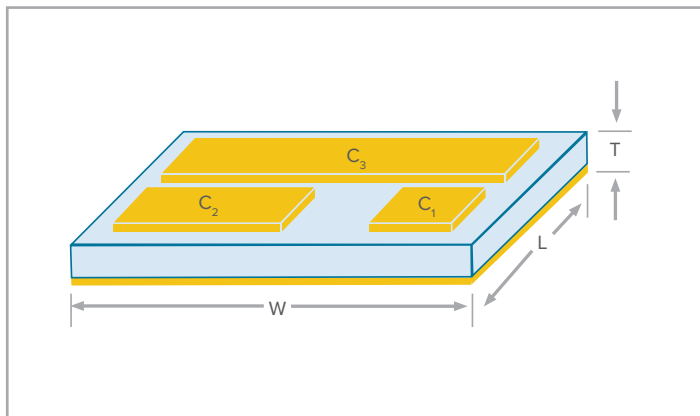
F	15	NR	OR1	M	1	P	X	3	
Product	Case Size	Material	Capacitance (pF)	Tolerance	Voltage	Termination	Test Level	Pad Quantity	Packaging
F = Binary Capacitors	15 20 25 35 40	See material tables on Page 5.	Lowest Value in Series is Part Number R08 = .08 pF OR1 = .1 pF OR2 = .2 pF OR4 = .4 pF OR5 = .5 pF Consult an inside sales rep for custom solutions.	A = $\pm 0.05\text{pF}$ B = $\pm 0.10\text{pF}$ C = $\pm 0.25\text{pF}$ D = $\pm 0.50\text{pF}$ K = $\pm 10\%$ L = $\pm 15\%$ M = $\pm 20\%$ X = GMV Z = +80% -20%	2 = 25V 5 = 50V 1 = 100V	P = TiW/NiV/Au or Ni/Au M = TiW/Au	X A B D E See test level definitions on page 7.	3 4	T = Tape and Reel Leave blank for generic waffle pack. See packaging definitions on Page 8.



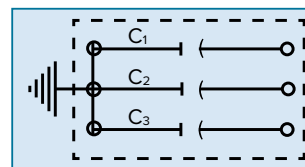
SLC – Bi-Cap®

Part Number	No. of Caps	Values (pF)	Voltage (WVDC)	Length	Width	Thickness	Border
F15CGR08M5PX3	3	0.08, 0.15, 0.3	50	0.015" ± 0.001" (0.381mm ± 0.025mm)	0.015" ± 0.001" (0.381mm ± 0.025mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	0.002" (0.051mm)
F15NR0R1M1PX3	3	0.1, 0.2, 0.4	100	0.015" ± 0.001" (0.381mm ± 0.025mm)	0.015" ± 0.001" (0.381mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F20CG0R1M1PX3	3	0.1, 0.2, 0.4	100	0.020" ± 0.001" (0.508mm ± 0.025mm)	0.020" ± 0.001" (0.508mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F20NR0R2M1PX3	3	0.2, 0.4, 0.8	100	0.020" ± 0.001" (0.508mm ± 0.025mm)	0.020" ± 0.001" (0.508mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F25CFR08M5PX3	3	0.08, 0.15, 0.3	50	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.004" ± 0.001" (0.102mm ± 0.025mm)	
F25CG0R2M1PX3	3	0.2, 0.4, 0.8	100	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F25NR0R4M1PX3	3	0.4, 0.8, 1.6	100	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.025" ± 0.001" (0.635mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F35CF0R1M1PX3	3	0.1, 0.2, 0.4	100	0.035" ± 0.001" (0.889mm ± 0.025mm)	0.035" ± 0.001" (0.889mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F35CG0R4M1PX3	3	0.4, 0.8, 1.6	100	0.035" ± 0.001" (0.889mm ± 0.025mm)	0.035" ± 0.001" (0.889mm ± 0.025mm)	0.006" ± 0.001" (0.152mm ± 0.025mm)	
F40NR0R5M1PX4	4	0.5, 1, 2, 4	100	0.040" ± 0.001" (1.016mm ± 0.025mm)	0.040" ± 0.001" (1.016mm ± 0.025mm)	0.0075" ± 0.001" (0.191mm ± 0.025mm)	

DIMENSIONS – Bi-CAP®



CIRCUIT DIAGRAM – Bi-CAP®



$C_1 = 1$
 $C_2 = 2 \times C_1$
 $C_3 = 4 \times C_1$
 (4 pad - $C_4 = 8 \times C_1$)

Pads may be used singularly or in combination to tune circuit.

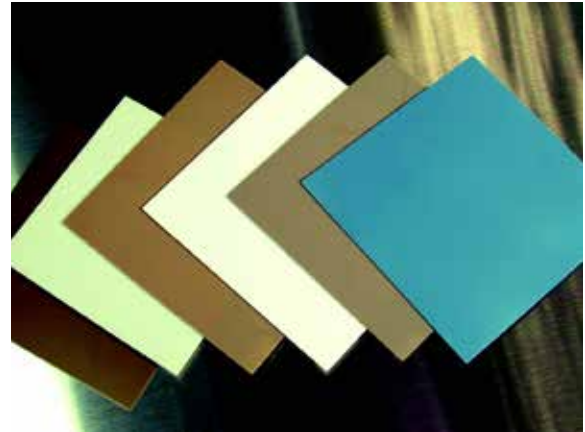


Complex Materials and Metallization

Complex utilizes an extensive variety of materials in both Class I and Class II categories with dielectric constants ranging from 3.8 to 35,000 to fabricate our components. Complex offers only commercial testing. For extra testing requirements, refer to Knowles SLC offerings or consult the sales office.

CLASS I DIELECTRIC MATERIALS:

This class of dielectrics consists of material exhibiting very low losses, extremely low or closely controlled temperature coefficients, negligible voltage and frequency coefficients, negligible aging effects and high insulation and dielectric breakdown.



CLASS I DIELECTRIC MATERIALS

Type	Ins. Res (MEG-OHMS 100VDC @ 25°)	Temperature Coefficient PPM°C -55 to 125°C	Dissipation Factor (@ 1MHz)	Dielectric Constant (K)	Material
C-20	10 ⁶	Negligible	0.0001	3.8	Quartz
C-28		P120 ± 25	0.0001	8.7	AlN
C-30		P180 ± 50	0.0006	9.6	Alumina 96
C-35		P180 ± 50	0.0006	9.8	Alumina 99.6
C-37		NPO 0 ± 30	0.0001	12.6	Titanate
C-40		0 ± 30	0.0010	20	Titanate
C-50		0 ± 30	0.0020	40	Titanate
C-55		0 ± 30	0.0050	50	Titanate
C-58		0 ± 30	0.0050	93	Titanate
C-NR		N1500 ± 500	0.0025	160	Titanate

Typically used for submounts and substrates only.

CLASS II DIELECTRIC MATERIALS:

This class of material is characterized by high dielectric constants, increased losses, and higher temperature coefficients. These properties are inherent with this class of material, but the high dielectric constants permit the use of smaller size to achieve low series inductance and meet dimensional requirements. Capacitors made with these materials are often used for coupling of microstrip line circuits where the small chip size is necessary. Used as bypass capacitors, the small size provides low series inductance and dielectric losses are typically of little concern.

CLASS II DIELECTRIC MATERIALS

Type	Ins. Res (MEG-OHMS 100VDC @ 25°)	Temperature Coefficient (%) -55 to 125°C	Dissipation Factor (@ 1MHz)	Aging (%) HR/ Decade	Dielectric Constant (K)
C-80	10 ⁵	5 to -10	0.010	2.0	300
C-BD	10 ⁴	-10 to 10	0.025	3.0	700
C-BE	10 ⁴	-10 to 10	0.025	3.0	1,250
C-100	10 ⁵	3 to -10	0.015	3.5	2,200
C-120	10 ⁵	0 to -35	0.020	3.0	3,500
C-BN	10 ⁵	-15 to 15	0.030	3.0	4,500
C-140	10 ⁵	0 to -80	0.025	3.0	11,000
C-200	10 ³	-15 to 15	0.035	3.0	25,000
C-400	10 ³	-15 to 15	0.035	3.0	35,000

* Please consult the factory for specific ratings to meet your application requirements.

Note: MHz @1V <100pF, 1kHz @1V >100pF Voltage Rating: ≤5 mils thick-50 WVDC (25 WVDC for 200 material), >5 mils thick-100 WVDC (50 WVDC for 200 material). Insulation Resistance tested at 50 volts for all materials except C-200. C-200 tested at WVDC that is 16-25V for ≤6 mils thick and 25-50V for >6 mils.

MATERIAL

C-400: Ultra High K X7R material.
Capacitance change ± 15% from -55 to 125°C.
200pF in a 10 x 10 size.
1,000pF in a 25 x 25 size.

SUBSTRATES CAN BE SUPPLIED AS FOLLOWS:

- Metallized
 - gold over platinum, palladium or nickel
 - silver over platinum
 - custom schemes and patterns to customer specifications
- Thickness range: mils and up
- Length and Width: up to 4" depending on material

STANDARD ELECTRODE METALLIZATIONS

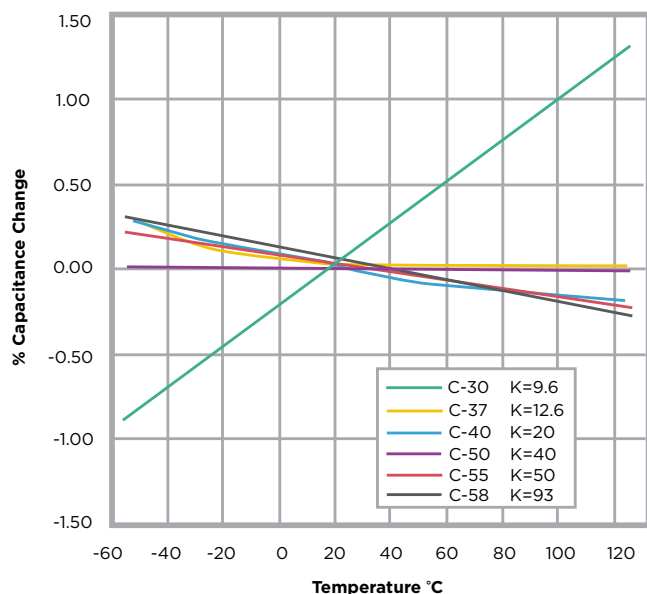
GOLD (G): This metallization consists of a minimum of 70 micro-inches of gold over non-magnetic leach-resistant nickel or platinum, which is ideal for all wire bonding methodologies. Please consult our factory for optimum metallization options for solder applications.

SILVER (S): This metallization consists of 20 micro-inches of silver over platinum, which is ideal for all solder applications whenever the use of gold is unacceptable.

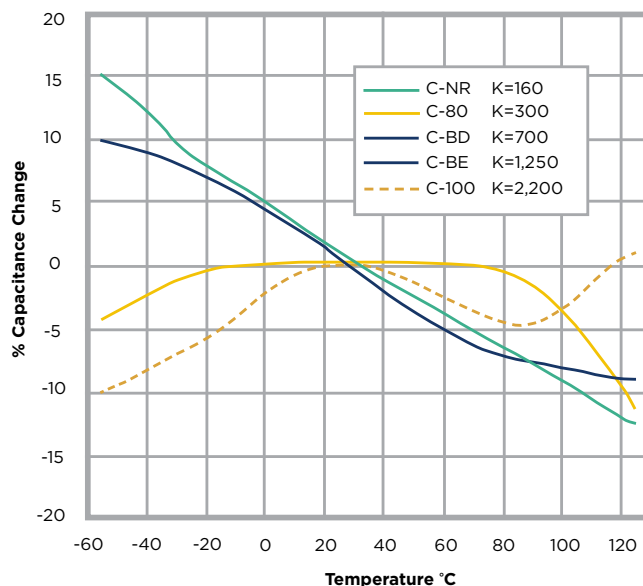


Typical Temperature Characteristics

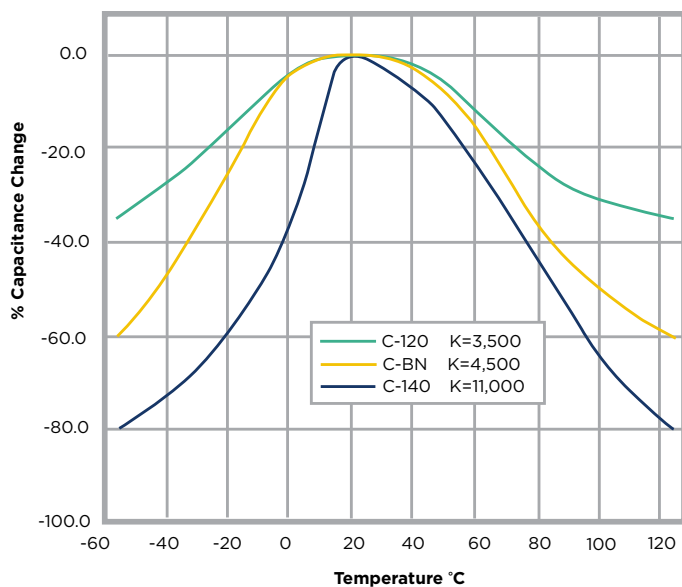
C-30/C-37/C-40/C-50/C-55/C-58



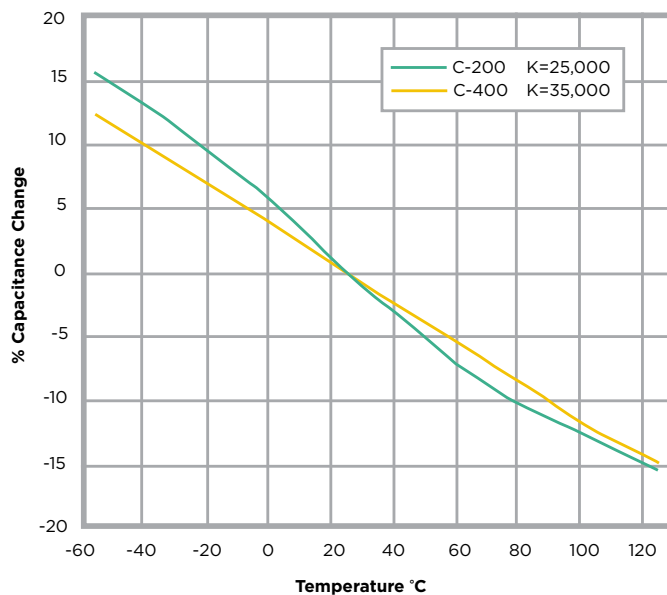
C-NR/C-80/C-BD (C-BE)/C-100



C-120/C-BN/C-140



C-200/C-400



CSA Series – Edge-to-Edge Capacitors

This classic two-electrode design is the simplest and most widely used. The chip size, shape and electrical properties may be determined from the dielectric material data and the CSA Selection Chart. Compex is the leader in supplying the LC filter market with custom value parallel plate capacitors. We manufacture tight tolerance, custom filter capacitors to the required size, shape and value for minimization of post build tuning requirements. Thicknesses of up to 25+ mils are available, utilizing temperature-stable low-loss materials and special terminations to improve the all solder process.

DESCRIPTION

- Capacitance: 0.04 to 10,000 picofarads and beyond
- Square or rectangle, length or width .008" and up



CSA STANDARD CAPACITANCE TOLERANCE CODES

Class I Dielectrics: C-20 thru C-NR		Class II Dielectrics: C-80 thru C-400	
Tolerance	Code	Tolerance	Code
±50pF	D	-20% thru +80%	Z
±25pF	C	Guaranteed Min. Value	GMV
±10pF	B	± 20%	M
±.05pF	A	± 15%	L
±.01pF	P	± 10%	K
± 20%	M	± 5%	J
± 15%	L		
± 10%	K		
± 5%	J		
± 3%	H		
± 2%	G		

For H and G tolerances, part thickness has to be >10mils. Consult factory for H and G tolerance parts

CSA STANDARD DIMENSIONAL TOLERANCES

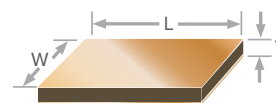
Material	L or W Dimension	Thickness	Tolerance
C-20 through C-140	< 20 mils	± 1.5 mils	± 15%
	≥ 20 mils		± 10%
C-200 and C-400	≤ 15 mils		± 2 mils
	>15 mils; ≤ 30 mils		± 3 mils
	> 30 mils		± 5 mils

CSA ELECTRODE CONFIGURATION

Two electrodes



CSA CHIP DIMENSIONS



To determine rectangular chip dimensions, divide the total chip area by the required length or width to obtain the remaining dimension.

ORDERING INFORMATION – CSA SERIES – EDGE-TO-EDGE CAPACITORS

CSA Cap Style	200 Dielectric Type	10 x 10 Length x Width (mils)	x 6 Thickness (mils)	G Metallization	101 Capacitance (pF)	M Capacitance Tolerance
CSA	See Class I and Class II tables (page 29)	See CSA Chip Dimensions (at right)	See CSA Selection Chart (at right)	G = Gold S = Silver Custom	First two digits represent significant figures and the last, the number of zeros to follow. When required, the letter "R" is used as a decimal point and the succeeding digits represent significant figures only. e.g.: 101 = 100pF, 1R6 = 1.6pF	See CSA Standard Capacitance Tolerance Codes (Above)

Example shown: Compex Series CSA, dielectric type C-200, .010" x .010" x .005", gold, 2.7pF, ±20% tolerance

Please contact factory to request free samples.



CSA Series — Edge-to-Edge Capacitors

CSA SELECTION CHART

Note: Selection Chart is for guidance only. All Compex parts are built to specific customer requirements.

Capacitor Size in Mils

MATERIAL	10x10			12x12			15x15			20x20			25x25			30x30			35x35			40x40			50x50		
	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance
C-20	0.01	0.03		0.01	0.04		0.02	0.06		0.04	0.10		0.06	0.15		0.09	0.23		0.13	0.31		0.16	0.28		0.25	0.44	
C-28	0.02	0.06		0.03	0.09		0.05	0.14		0.09	0.23		0.14	0.36		0.21	0.52		0.28	0.71		0.37	0.65		0.58	1	
C-30	0.02	0.07	P	0.03	0.1	P	0.05	0.15	A	0.1	0.26	A	0.16	0.4	A	0.23	0.57	B	0.31	0.77	B	0.4	0.71	B	0.63	1.1	B
C-35	0.02	0.07	P	0.03	0.1	P	0.05	0.16	A	0.1	0.26	A	0.16	0.41	A	0.23	0.59	B	0.31	0.79	B	0.41	0.72	B	0.64	1.1	B
C-37	0.03	0.09	P	0.04	0.13	A	0.07	0.2	A	0.13	0.33	A	0.21	0.52	A	0.3	0.75	B	0.4	1	B	0.53	0.9	B	0.83	1.4	C
C-40	0.05	0.14	A	0.07	0.2	A	0.1	0.32	A	0.21	0.53	B	0.32	0.82	B	0.47	1.2	C	0.64	1.6	C	0.84	1.4	C	1.3	2.3	C
C-50	0.09	0.29	A	0.14	0.42	A	0.21	0.65	B	0.41	1	B	0.66	1.6	C	0.94	2.4	C	1.3	3.2	D	1.7	3	C	2.6	4.6	D
C-55	0.12	0.37	A	0.17	0.52	A	0.26	0.82	B	0.53	1.4	C	0.82	2	C	1.2	3	C	1.6	4.1	D	2.1	3.7	D	3.2	5.8	D
C-58	0.22	0.67	B	0.31	0.9	B	0.49	1.5	C	0.98	2.5	C	1.5	3.8	D	2.2	5.5	D	3	7.6	K	3.9	6.9	K	6.1	11	K
C-NR	0.35	1.1	B	0.51	1.5	C	0.79	2.5	C	1.6	4	D	2.4	6.2	K	3.6	9	K	4.8	12	K	6.3	11	K	9.8	17	K
C-80	0.7	2.2	K	1.01	3.1	K	1.6	4.8	K	3.1	7.9	K	4.9	13	K	7.1	18	K	9.7	25	K	13	22	K	20	35	K
C-BD	1.8	5.8	K	2.6	8.3	K	4.3	13	K	8.4	21	K	13	33	K	18	48	K	25	65	K	33	60	K	53	90	K
C-BE	2.9	9	K	4.3	13	K	6.6	20	K	13	33	K	21	52	K	30	75	K	40	100	K	53	90	K	82	140	K
C-100	5.2	16	K	7.4	23	K	12	36	K	23	58	K	36	90	K	52	130	K	70	180	K	92	160	K	150	260	K
C-120	8.2	26	K	12	37	K	18	57	K	37	90	K	58	140	K	83	210	K	113	280	K	150	260	K	230	410	K
C-BN	10.2	31	K	15	46	K	23	71	K	46	120	K	72	180	K	104	260	K	140	360	K	180	320	K	290	510	K
C-140	25	80	M	37	110	M	58	180	M	120	290	M	180	450	M	260	650	M	360	900	M	460	820	M	720	1300	M
C-200	52	200	M	81	270	M	140	390	M	230	720	M	390	1100	M	590	1500	M	720	2200	M	990	2000	M	1600	2900	M
C-400	72	270	M	113	370	M	200	550	M	320	1000	M	550	1500	M	830	2100	M	1020	3100	M	1400	2700	M	2300	4100	M



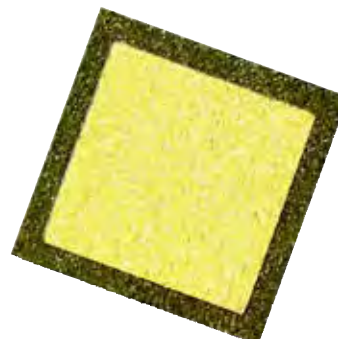
CSM Series – Margin Capacitors

Margin caps have the topside electrode withdrawn from the edges in order to increase the distance between electrodes and dramatically decrease the possibilities of shorting when epoxy die-mounting. This style is also widely used for optical recognition-based assembly.

Increased margin sizes and special terminations are available for high power LC filter applications.

DESCRIPTION

- Margin capacitors can be customized to any sized square or rectangle



CSM STANDARD CAPACITANCE TOLERANCE CODES

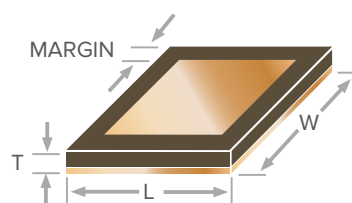
Class I Dielectrics: C-20 thru C-NR		Class II Dielectrics: C-80 thru C-400	
Tolerance	Code	Tolerance	Code
±50pF	D	-20% thru +80%	Z
±25pF	C	Guaranteed Min. Value	GMV
±10pF	B	± 20%	M
±05pF	A	± 15%	L
±01pF	P	± 10%	K
± 20%	M	± 5%	J
± 15%	L		
± 10%	K		
± 5%	J		
± 3%	H		
± 2%	G		

For H and G tolerances, part thickness has to be >10mils. Consult factory for H and G tolerance parts

CSM STANDARD DIMENSIONAL TOLERANCES

Length & Width	L or W Tolerance	Margin Nominal	Thickness
≤.010	± .002	.001	± .0015
.011 thru .029	± .002	.002	
≥.030	± .003	.002	
All dimensions given are inches			

CSM CHIP DIMENSIONS



CSM ELECTRODE CONFIGURATION

Two electrodes



ORDERING INFORMATION – CSM SERIES – MARGIN CAPACITORS

CSM Style	BE Dielectric Type	10 x 10 Length x Width (mils)	x 5 Thickness (mils)	G Metallization	2R9 Capacitance (pF)	M Capacitance Tolerance
CSM	See Class I and Class II tables (page 29)	See CSM Chip Dimensions (at right)	See CSM Selection Chart (at right)	G = Gold	First two digits represent significant figures and the last, the number of zeros to follow. When required, the letter "R" is used as a decimal point and the succeeding digits represent significant figures only. e.g.: 101 = 100pF, 1R6 = 1.6pF	See CSM Standard Capacitance Tolerance Codes (above)

Example shown: Compex Series CSM, dielectric type C-BE, .010" x .010" x .005", gold, 2.9pF, ±20% tolerance

Please contact factory to request free samples.



CSM Series – Margin Capacitors

CSM SELECTION CHART

Note: Selection Chart is for guidance only. All Compex parts are built to specific customer requirements.

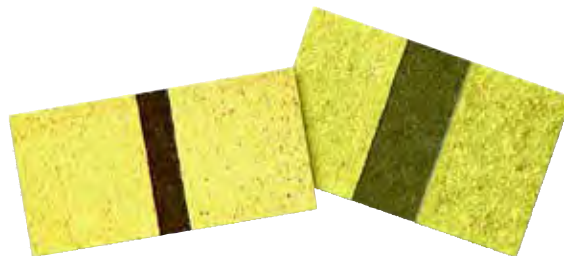
Capacitor Size in Mils

MATERIAL	10x10			12x12			15x15			20x20			25x25			30x30			35x35			40x40			50x50		
	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance
C-20	0.01	0.02		0.02	0.03		0.03	0.04		0.05	0.07		0.07	0.11		0.11	0.17		0.15	0.23		0.20	0.22		0.30	0.35	
C-28	0.03	0.04	P	0.04	0.06		0.06	0.09		0.11	0.16		0.17	0.26		0.24	0.38		0.33	0.54		0.44	0.5		0.69	0.8	
C-30	0.03	0.05	P	0.04	0.07	P	0.06	0.09	P	0.12	0.18	A	0.18	0.29	A	0.26	0.43	A	0.37	0.59	B	0.48	0.55	B	0.76	0.9	B
C-35	0.03	0.05	P	0.04	0.07	P	0.07	0.09	P	0.12	0.18	A	0.18	0.3	A	0.28	0.43	A	0.38	0.6	B	0.49	0.57	B	0.77	0.9	B
C-37	0.04	0.06	A	0.06	0.09	P	0.08	0.12	A	0.15	0.23	A	0.24	0.38	A	0.36	0.56	B	0.48	0.77	B	0.63	0.73	B	0.99	1.2	B
C-40	0.06	0.1	A	0.09	0.14	A	0.14	0.2	A	0.24	0.37	A	0.38	0.6	B	0.56	0.9	B	0.76	1.2	C	1	1.2	C	1.6	1.9	C
C-50	0.13	0.2	A	0.18	0.29	A	0.26	0.39	A	0.48	0.74	B	0.77	1.2	B	1.12	1.8	C	1.5	2.5	C	2	2.3	C	3.1	3.7	D
C-55	0.16	0.25	A	0.23	0.37	A	0.33	0.48	A	0.61	0.9	B	0.95	1.5	C	1.4	2.2	C	2	3.1	C	2.5	2.9	C	3.9	4.6	D
C-58	0.29	0.46	A	0.43	0.68	B	0.62	0.9	B	1.13	1.7	C	1.8	2.8	C	2.6	4.1	D	3.6	5.7	D	4.7	5.4	D	7.4	9	K
C-NR	0.47	0.74	B	0.68	1.1	B	1	1.4	C	1.8	2.8	C	2.9	4.5	D	4.1	6.6	K	5.8	9	K	7.5	9	K	12	14	K
C-80	0.94	1.4	K	1.4	2.2	K	2	2.9	K	3.7	5.5	K	5.8	9	K	8.4	14	K	12	19	K	15	17	K	24	27	K
C-BD	2.5	4	K	3.7	5.8	K	5.3	7.8	K	9.7	14	K	15	24	K	22	36	K	31	49	K	40	47	K	63	73	K
C-BE	3.9	6.2	K	5.6	9	K	8.3	12	K	15	23	K	24	37	K	35	55	K	48	77	K	63	72	K	99	110	K
C-100	6.9	11	K	10	16	K	15	21	K	26	41	K	43	66	K	61	90	K	84	140	K	110	130	K	170	200	K
C-120	10.9	17	K	16	26	K	23	34	K	43	65	K	67	100	K	98	150	K	140	210	K	170	200	K	280	320	K
C-BN	14	22	K	20	32	K	29	43	K	53	82	K	84	140	K	130	200	K	170	270	K	220	260	K	350	400	K
C-140	35	54	M	49	80	M	72	110	M	140	200	M	210	330	M	310	480	M	430	670	M	550	640	M	860	1000	M
C-200	78	130	M	114	180	M	160	250	M	300	460	M	480	750	M	700	1100	M	950	1500	M	1300	1400	M	2000	2300	M
C-400	109	170	M	160	260	M	230	340	M	430	650	M	670	1000	M	980	1500	M	1400	2100	M	1700	2000	M	2800	3200	M



CSB Series – Dual-Pad Capacitors

A single full electrode is provided on one side of the capacitor and split electrodes on the other side. This is a three-terminal capacitor that can be used as two capacitors with a common electrode, or as serially connected capacitors so that connections may be made on one side of the chip only (surface-mount). This design is often used in microstrip coupling to eliminate lead inductance and raise the self resonance frequency.



DESCRIPTION

- Capacitance: 0.06 picofarads and up
- Chip shapes: dual pads with gap
- Gap widths: 5, 10, 15, 20 mil or custom

CSB STANDARD CAPACITANCE TOLERANCE CODES

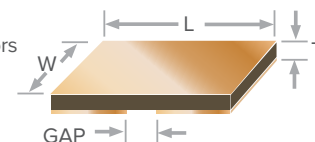
Class I Dielectrics: C-20 thru C-NR		Class II Dielectrics: C-80 thru C-400	
Tolerance	Code	Tolerance	Code
± 20%	M	-20% thru +80%	Z
± 15%	L	Guaranteed Min. Value	GMV
± 10%	K	± 20%	M
		± 15%	L
		± 10%	K

CSB STANDARD DIMENSIONAL TOLERANCES

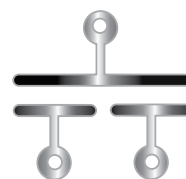
Length & Width (mils)	L or W Tolerance	Thickness (mils)
≤ 20	± 15%	± 1.5
≥ 20	± 10%	

CSB CHIP DIMENSIONS

This component functions as two capacitors operating in series, each of which is twice the desired equivalent capacitance. Allow us to custom design for your application.



CSB ELECTRODE CONFIGURATION



Split electrodes

ORDERING INFORMATION – CSB SERIES – EDGE-TO-EDGE CAPACITORS

CSB Style	100 Dielectric Type	50 x 20 Length x Width (mils)	x 7 Thickness (mils)	10 Gap (mils)	6 Metallization	120 Capacitance (pF)	M Capacitance Tolerance
CSB	See Class I and Class II tables (page 29)	See CSB Chip Dimensions (pg 38)	See CSB Selection Chart (pg 38)	5 or higher	G = Gold S = Silver Custom	First two digits represent significant figures and the last, the number of zeros to follow. When required, the letter "R" is used as a decimal point and the succeeding digits represent significant figures only. e.g.: 101 = 100pF, 1R6 = 1.6pF	See CSB Standard Capacitance Tolerance Codes (above)

Example shown: Compex Series CSB, dielectric type C-100, .050" x .020" x .007", .01" gap, gold, 12pF, ±20% tolerance

Please contact factory to request free samples.



CSB Series – Dual-Pad Capacitors

CSB SELECTION CHART

Note: Selection Chart is for guidance only. All Complex parts are built to specific customer requirements.

Capacitor Size in Mils

MATERIAL	20x10			40x20			60x30			80x40		
	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance	MIN.	MAX.	Tolerance
C-30	0.02	0.03	P	0.04	0.07	P	0.06	0.09	P	0.12	0.18	A
C-37	0.03	0.03	P	0.06	0.09	P	0.08	0.12	A	0.15	0.23	A
C-40	0.04	0.05	P	0.09	0.14	A	0.14	0.2	A	0.24	0.37	A
C-50	0.06	0.1	A	0.18	0.29	A	0.26	0.39	A	0.48	0.74	B
C-55	0.07	0.1	A	0.23	0.37	A	0.33	0.48	A	0.61	0.9	B
C-58	0.14	0.2	A	0.43	0.68	B	0.62	0.9	B	1.13	1.7	C
C-NR	0.2	0.4	B	0.68	1.1	B	1	1.4	C	1.8	2.8	C
C-80	0.5	0.9	K	1.4	2.2	K	2	2.9	K	3.7	5.5	K
C-BD	1.1	2	K	3.7	5.8	K	5.3	7.8	K	9.7	14	K
C-BE	1.9	3.5	K	5.6	9	K	8.3	12	K	15	23	K
C-100	3.1	5.5	K	10	16	K	15	21	K	26	41	K
C-120	4.8	8.7	K	16	26	K	23	34	K	43	65	K
C-BN	5.5	9.9	K	20	32	K	29	43	K	53	82	K
C-140	17	30	M	49	80	M	72	110	M	140	200	M
C-200	34	62	M	114	180	M	160	250	M	300	460	M
C-400	48	87	M	160	260	M	230	340	M	430	650	M

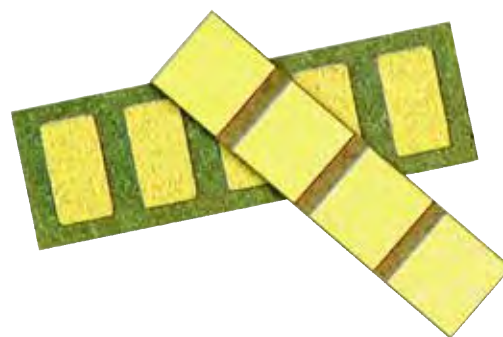


CR/CM Series – Row Capacitors

Row capacitors are used where arrays of capacitors (not necessarily identical) are needed, usually for decoupling/bypass of GaAs integrated circuits. Standard arrays can contain up to 10 capacitors from 0.04pF on up. Typical overall dimensions range from 20 x 10 mils on up. Parts can be fully customized to meet the requirements of your application to provide the shortest lead length possible.

DESCRIPTION

Row caps (CR) are also available with margins (CM) surrounding the edges to help prevent epoxy shorts and aid optical recognition systems.



CR/CM STANDARD CAPACITANCE TOLERANCE CODES

Class I Dielectrics: C-20 thru C-NR	
Tolerance	Code
± 20%	M
± 15%	L
± 10%	K

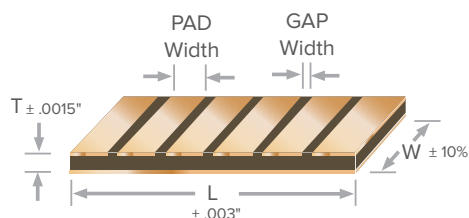
Class II Dielectrics: C-80 thru C-400	
Tolerance	Code
-20% thru +80%	Z
Guaranteed Min. Value	GMV
± 20%	M
± 15%	L
± 10%	K

CR/CM SERIES

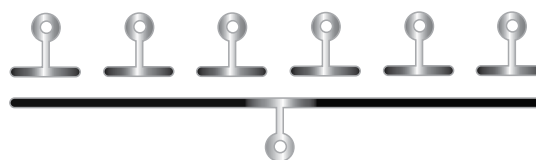
All Compex parts are built to specific customer requirements.

Please consult sales when ordering a CR/CM part.

CR6 CHIP DIMENSIONS



CR/CM ELECTRODE CONFIGURATION



ORDERING INFORMATION – CR/CM SERIES – ROW CAPACITORS

CR	6	BN	105 x 25	x 4	5	G	101	Z
Cap Style	No. of Caps	Dielectric Type	Length x Width (mils)	Thickness (mils)	Gap (mils)	Metallization	Capacitance (pF)	Capacitance Tolerance
CR = Row CM = Margin	-	See Class I and Class II tables (page 29)	See CR/CM Chip Dimensions (at right)	See CR/CM Chip Dimensions (at right)		G = Gold Custom	First two digits represent significant figures and the last, the number of zeros to follow. When required, the letter "R" is used as a decimal point and the succeeding digits represent significant figures only. e.g.: 101 = 100pF, 1R6 = 1.6pF	See CR/CM Standard Capacitance Tolerance Codes (above)

Note: Example shown: Compex Series CR, dielectric type C-BN, 105" X .025" X .004", gold, 100pF, +80 to -20% tolerance, 6 cap. chip

Please contact factory to request free samples.



High-K Ceramic Substrates & Plates

High-K substrates are used for circuit miniaturization.
DLI offers complete fabrication services.

CASE SIZES AND TOLERANCES

For custom sizes, please contact the sales office.

Case Size (Inches)	Length (Inches)	Width (Inches)	L&W Tolerance ±(Inches)	Thickness Tolerance ±(Inches)
10	1.000	1.000	.050	.002
15	1.000	1.500	.050	.002
20	2.000	2.000	.050	.002
25	2.500	2.500	.050	.002
30	3.000	3.000	.050	.002
40	4.000	4.000	.050	.002



MATERIAL SPECIFICATIONS

Material Code	Relative ϵ_R^* @ 5 GHz	TCC [†] Loss ppm/°C	Coefficient of Tangent* % Max	Thermal Expansion ppm/°K	Conductivity W/m-°K
QZ	3.82 (@ 1MHz)	Fused Quartz	0.0015 (@ 1MHz) 0.033 (@ 24 GHz)	0.55	1.28
AG	8.85 ± 0.35 (@ 1MHz)	Aluminum Nitride	0.10	4.6	140 - 180
PI	9.9 ± 0.15 (@ 1MHz)	Alumina 99.6%	0.01	6.5 - 7.5	27
PG	12.5 ± 0.5	P22 ± 30	0.02	7.6	-
AH	20 ± 0.5	P90 ± 20	0.02	9.6	1.56
NA	23 ± 1	N30 ± 15	0.03	10.1	1.56
CF	25 ± 2	0 ± 15	0.15	9.0	1.56
CD	38 ± 1	N20 ± 15	0.04	5.8	1.59
CG	67 ± 3	0 ± 30	0.10	9.0	1.59
NR	152 ± 5	N1500 ± 500	0.06	10.0	2.72

*Unless otherwise specified, K dielectric measurement at approximately 5 GHz. †For the temperature range -55 to 125°C.

High-K Ceramic Substrates & Plates

METALLIZATION

Code	Description
X	No Metallization
M	300 Angstroms TiW, 100 μ in. min. Au
N	300 Angstroms TiW, 50 μ in. min. NiV, 100 μ in. min. Au
P	75 μ in. min. Nickel, 100 μ in. min. Au
L	Top 50 Ohms/sq. TaN, 300 Angstroms TiW, 100 μ in. min Au
	Bottom Side 300 Angstroms TiW, 100 μ in. min. Au
T	300 Angstroms min. TiW, 50 μ in. min. NiV, 300 μ in. min. Au-Sn
D	Special customer drawing required

SURFACE FINISH

Code	Roughness R	Material Process
X	>50 μ in.	As-Fired
Y	20 μ in.	Machined
Z	<5 μ in.	Polished
S	Special customer drawing required	

SCREENING OPTIONS

Test Code	Test/Inspection	Sample Size	Description
X	Visual Mechanical	100%	Verify that the required area is available and continuous (Broken corners allowable).
D	Customer Defined	-	Special customer drawing required
	Kent Test	10% of lot	K and Loss.

ORDERING INFORMATION – SLC – HIGH-K CERAMIC SUBSTRATES & PLATES

H Product	20 Case Size	CG Material	250 Thickness	D Thickness Tolerance	Z Surface Finish	N Metallization	X Test Level
H = Substrate	10 15 20 25 30 40	See material table on page 42.	Thickness Code. A three-digit code representing the thickness in mils. Examples: Code 100 = .010", Code 155 = .0155", Code 250 = .025" Please consult with an applications engineer for thicknesses < .010"	Thickness Tolerance Codes D = $\pm .0005$ – Machined or Polished E = $\pm .001$ – Standard	X Y Z S See table above.	See table above.	X D See test level definitions above.



SLC – Heatsinks, Standoffs & Submounts

HEATSINKS

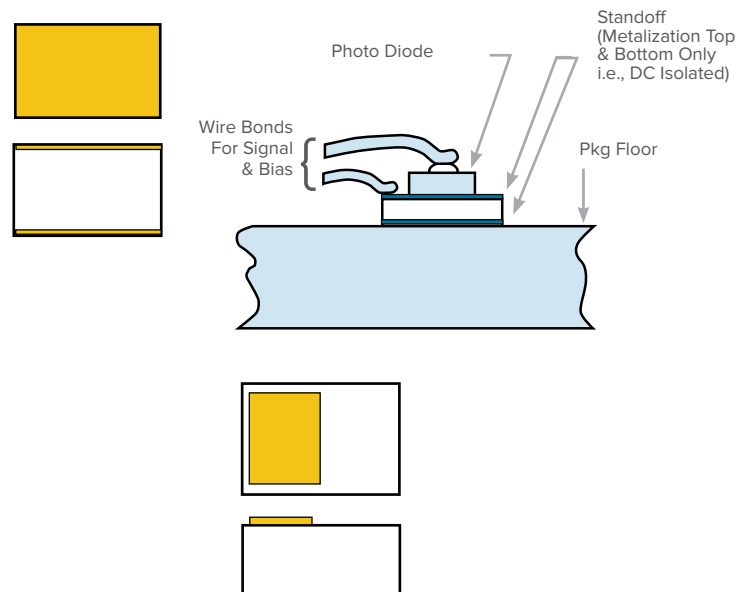
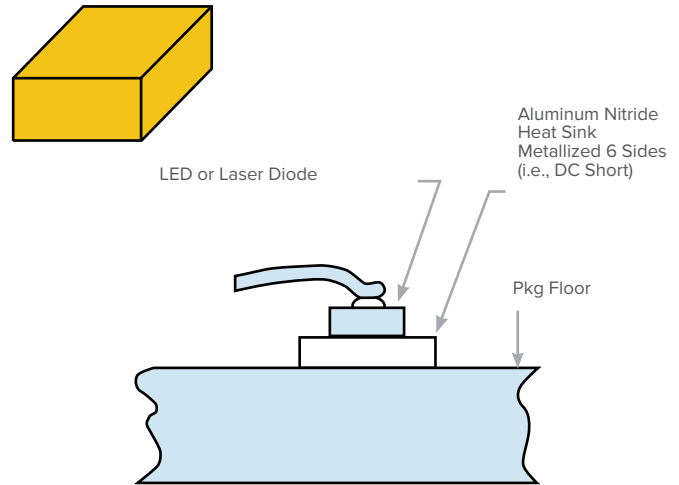
- Heatsinks are fully metallized on all sides and are used to dissipate and absorb heat
- Heatsinks allow for high thermal conductivity and are electrically conductive (DC short)
- Typically used with LEDs or laser diodes

STANDOFFS

- A Standoff is much like a Heatsink; however it is typically metallized on only the top and bottom surfaces
- Each device is custom tailored to the customer's specifications and is typically used with LEDs or Photo Diodes (works as a photo detector, light is allowed in through fibers)

SUBMOUNTS

- Submounts are ceramic LED package bases that minimize thermal resistance between LED junctions and adjacent components
- By reducing junction temperatures, an LED will produce increased efficiency, brightness, color and reliability
- Each device is custom tailored to the customer's specifications



SLC – Heatsinks, Standoffs & Submounts

MATERIAL SPECIFICATIONS

Material Code	Relative ϵ_R^* @ 5 GHz	TCC [†] Loss ppm/°C	Coefficient of Tangent* % Max	Thermal Expansion ppm/°K	Conductivity W/m-°K
AG	8.85 $\pm$ 0.35 (@ 1MHz)	Aluminum Nitride	0.10	4.6	140 - 180
PI	9.9 $\pm$ 0.15 (@ 1MHz)	Alumina 99.6%	0.01	6.5 - 7.5	27

*Unless otherwise specified, K dielectric measurement at approximately 5 GHz. [†]For the temperature range -55 to 125°C. **Material only provided metalized.

SURFACE FINISH

Code	Roughness R	Material Process
X	>50 μ in.	As-Fired
Y	20 μ in.	Machined
Z	<5 μ in.	Polished
S	Special customer drawing required	

METALLIZATION

Code	Description
M	300 Angstroms TiW, 100 μ in. min. Au
P	75 μ in. min. Nickel, 100 μ in. min. Au
E	Metallized and etched per customer drawing
T	300 Angstroms min. TiW, 50 μ in. min. NiV, 300 μ in. min. Au-Sn
D	Special customer drawing required

ORDERING INFORMATION – SLC – HEATSINKS, STANDOFFS & SUBMOUNTS

S Product	20 Case Size	AG Material	250 Thickness	D Thickness Tolerance	Z Surface Finish	N Metallization	X Test Level
S= Heatsinks, Standoffs, Submounts	10 15 20 25 30 40	See material table on page 42.	Thickness Code. A three-digit code representing the thickness in mils. Examples: Code 100 = .010", Code 155 = .0155", Code 250 = .025" Please consult with an applications engineer for thicknesses < .010"	Thickness Tolerance Codes D = $\pm$.0005 – Machined or Polished E = $\pm$.001 – Standard	X Y Z S See table above.	See table above.	X D See test level definitions above.



SBT Series – Submounts

Submount materials include quartz, alumina, and aluminum nitride.

Applications include heat sinks, standoffs, height matching, bonding pads and jumpers.

Custom sizes, patterns and shapes are available to your design specifications in thicknesses from 4 to 100 mils and beyond.



SUBMOUNT MATERIAL PROPERTIES CHART

	Quartz	Alumina	AlN
Material Code	C-20	C-30/35	C-28
Coefficient of Thermal Expansion (ppm/°C)	6	6.7	4.6
Thermal Conductivity (W/m-k)	1.6	26	170

ORDERING INFORMATION – SBT SERIES – SUBMOUNTS

SBT	-	28	-	20 x 20	x 6	-	G	-	S	5		
Cap Style		Material		Length x Width (mils)		Thickness (mils)		Metallization		Cut to Size		Thickness Tolerance
SBT = Edge-to-edge plated or bare CSX = Custom patterned		See Submount Material Properties Chart above		-		4 to +100 mils		G = Gold B = Bare Custom		-		(only utilized if <.001"; figure represents tenths of a mil)

Note: Standard dimensional tolerance is .001" for length, width, and thickness. Tighter Thickness tolerances down to .0002" are available.

Example: Compex Series SBT, dielectric type C-28, .020" x .020" x .006", gold, cut to size, .0005" thickness tolerance

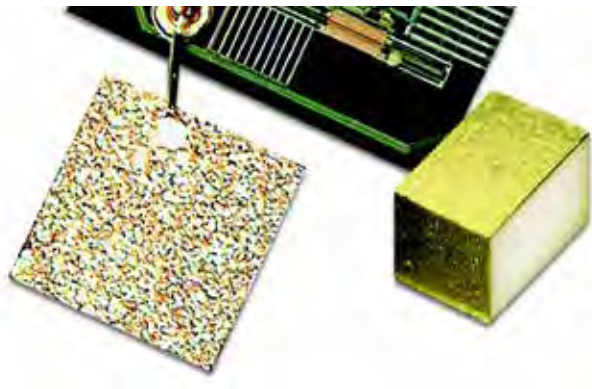


MST Series – Mounting Shorts

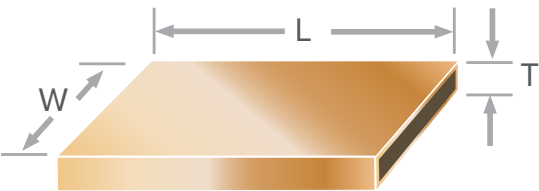
Alumina mounting shorts (or Aluminum Nitride for improved thermal properties), with metallization on the top, bottom and two of four sides, allow placement of a wirebond anywhere in the circuit, replacing the need for gold terminations on the substrate. They also can be used to raise the ground plane, reducing lead length for reduced inductance for high-speed/frequency applications, or to dissipate heat from under an IC or laser chip.

DESCRIPTION

- Instant bonding pads
- Fully conductive
- Height matching
- Replaces moly-tabs
- Any size available, as small as 0.007" x 0.007"



MST CHIP DIMENSIONS



Dimensional Tolerance: Standard is .001" for length, width and thickness.

WIREBOND



RAISED PLANE



Our ceramic mounting shorts are excellent replacements for kovar and moly-tabs. These ceramic shorts have a much sharper edge and are flat stable bases for mounting semiconductors.

ORDERING INFORMATION – MST SERIES – MOUNTING SHORTS

MST	-	30	-	25	x 20	x 6	-	G	-	S	5
Cap Style	Material	Length (mils)	Width (unmetallized side) (mils)		Thickness (mils)	Metallization	Cut to Size		Thickness Tolerance		
MST	C-28 C-30 C-35	-	-		4 to +100 mils	G = Gold Custom	-		(only utilized if <.001"; figure represents tenths of a mil)		

Example Shown: Complex Series MST, dielectric type C-30, .025" x .020" x .006", gold, cut to size, .0005" thickness tolerance

PX Series — Broadband Blocking Device

FEATURES

- X7R temperature and voltage stability
- Low frequency stability
- Low insertion Loss
- Solder or epoxy attachment

FUNCTIONAL APPLICATIONS

- Broadband Microwave/Millimeter Wave
- Test Equipment
- ROSA/TOSA
- SONET



SPECIFICATIONS — PX SERIES

Electrical

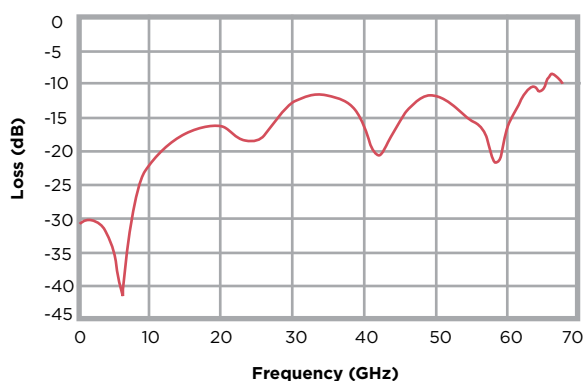
Temperature Coefficient of Capacitance	SLC: 120pF Guaranteed Minimum Value (GMV) MLC: 100nF $\pm 10\%$
Voltage	16WVDC
Dissipation Factor	3.0% @ 1MHz
Insulation Resistance	>103 M Ω
Assembly Process Temperature	250°C

Part Number	Metallization
PX42UX104KCZX	Sn (200 μ) / Ni (150-250 μ)
PX42UX104KCSX	Au (5-15 μ) / Ni (150-250 μ)
Packaging	(T) Tape & Reel - (W) Waffle Pack

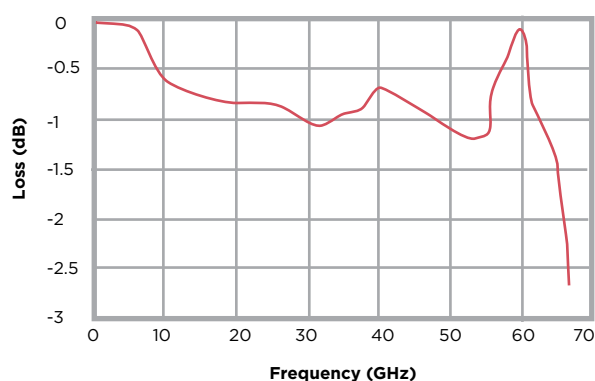
Mechanical

Pressure force	>2.5N (min)
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TYPICAL INSERTION LOSS (S21)

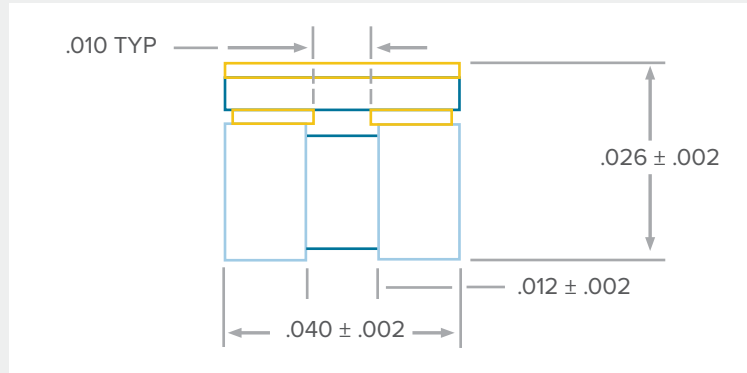


TYPICAL INSERTION LOSS (S11)



PX Series — Broadband Blocking Device

DIMENSIONS - PX SERIES BROADBAND BLOCKING DEVICE



ATTACHMENT METHODS — PX SERIES — BROADBAND BLOCKING DEVICE

Recommended attachment to soft or hard substrate using Solder:

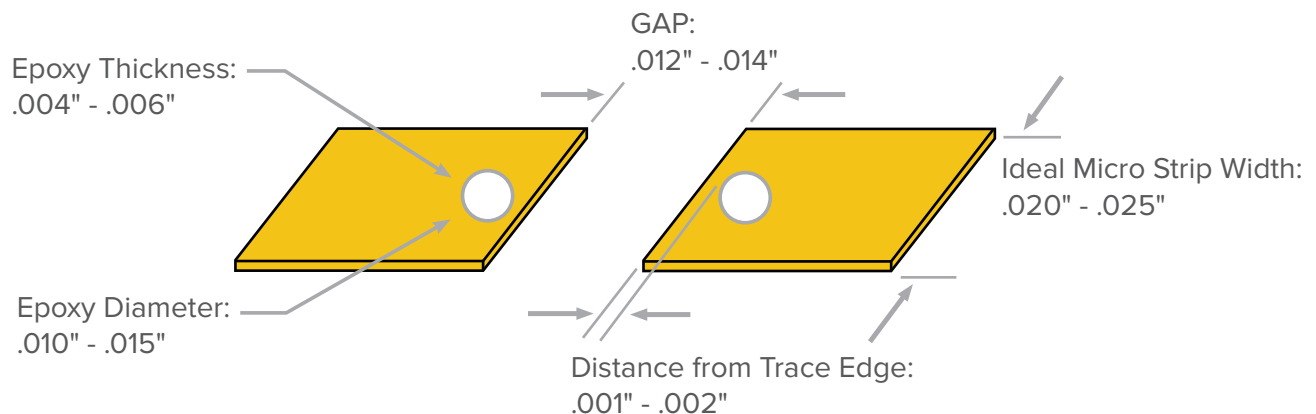
Recommended Microstrip Layout:

1. Place a single drop of solder paste onto each microstrip as illustrated; the edge of the solder shall be at least .001"-.002" back from the edge of the trace to prevent filling the gap with solder.
2. Centering the termination gap of the capacitor within the gap in the microstrip, press with careful, even pressure onto the microstrip ensuring the terminations make good contact with the drops of solder paste.
3. Reflow according to the solder manufacturer's preferred profile, ensuring the reflow temperature does not exceed 260°C.
4. After the reflow step is completed, inspect joint for voids or excess flux and non-reflowed solder balls that can degrade performance or cause shorts across the gaps. Proper cleaning after the reflow process is crucial to avoiding performance degradation and discovering poor solder joints.

Isopropanol and Methanol are both safe to use with soldered units.

Mounting

The part is designed for surface mounting using conventional reflow soldering techniques. In accordance with normal recommendations for ceramic MLCCs, hand soldering should be avoided as soldering irons could cause thermal damage or disconnections within the device. If rework or manual placing is necessary, then the use of a hot air pencil is recommended. Preheating the board can assist with manual soldering. Pb free compatible.



Ceramic Resonators

Coaxial TEM Resonators

Coaxial resonators made with modern, high performance ceramic dielectric materials are very useful as compact frequency standards, filter elements, and distributed inductive or capacitive circuit elements. The high Q obtained in the UHF, VHF, L, S, C bands and microwave frequency range makes these resonators ideal for many applications. **When cost, size, and stability are important, these resonators are the best choice.**

Coaxial resonators can be supplied as quarter wave resonators with one end fully metallized (i.e., shorted), and the other end open, fully metallized on both ends, or as half wave resonators with both ends open. For surface mounting, tabbed or tabless resonators can be provided for soldering directly to the circuit board. These resonators are pretuned to your specified frequency with a choice of tolerances.

In-house control of the pressing and firing of the green resonators ensures the optimum fired densities for the best electrical performance. Knowles Precision Devices proprietary silver metallization system produces the highest possible Q, exceptional solderability, and strongest metallization adhesion in the industry. Quarter and half wave resonators are precisely tuned to the specified frequency using the coupled transmission method and a network analyzer. Resonators are 100% screened for frequency to ensure that customer specifications are met.



FEATURES:

- Rugged, thermally stable ceramics
- Thick film silver coating for excellent Q and solderability
- Superior silver adhesion - pull strengths greater than 20 pounds
- Standard frequency tolerance is 0.1% - 1.0%; tighter tolerances available
- SMT tabs, tabless or slotted no tab configurations available for each size resonator

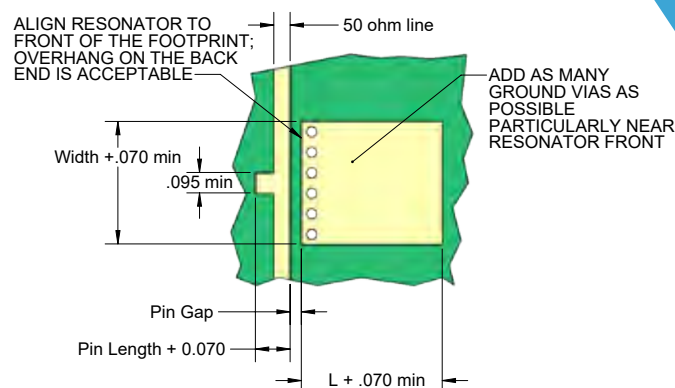
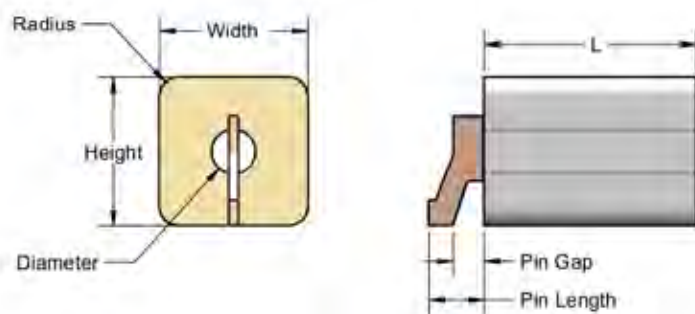
APPLICATIONS:

- Dielectric resonating oscillators (DRO)
- Voltage controlled oscillators (VCO)
- Global positioning systems (GPS)
- Cellular and wireless communications
- Bandpass/bandstop filters
- Narrowband/delay filters
- EMI filtering

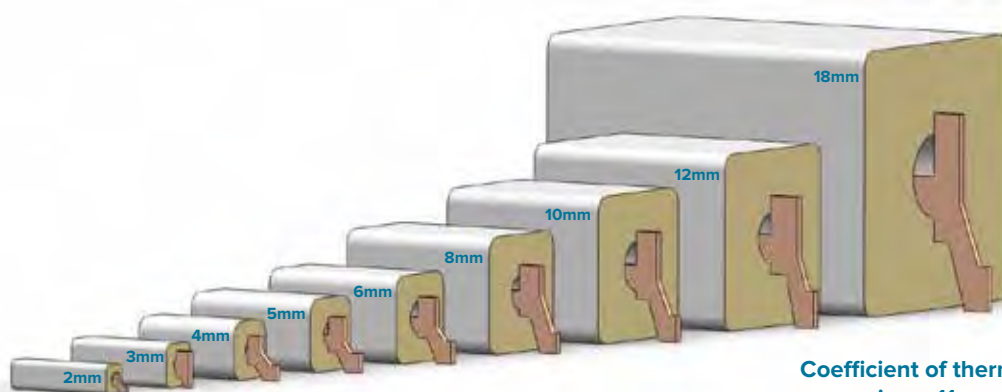


Ceramic Resonators

Tabbed Coaxial Resonators



Resonator Profile	Dielectric Material/ Constant	Width		Height		Diameter		Radius		Pin Length		Pin Gap	
		inches	mm	inches	mm	inches	mm	inches	mm	inches	mm	inches	mm
2 mm	9, 20, 38, 92	0.079" ± 0.003"	2 ± 0.08	0.079" ± 0.003"	2 ± 0.08	0.033" ± 0.003"	0.838 ± .08	0.015"	0.381	0.040"	1.016	0.020"	0.508
3 mm	5, 9, 13, 20, 36, 98	0.118" ± 0.003"	3 ± 0.08	0.118" ± 0.003"	3 ± 0.08	0.045" ± 0.003"	1.143 ± 0.08	0.020"	0.508	0.040"	1.016	0.020"	0.508
4 mm	5, 9, 13, 20, 36, 98	0.157" ± 0.004"	4 ± 0.102	0.157" ± 0.004"	4 ± 0.102	0.045" ± 0.003"	1.143 ± 0.08	0.040"	1.016	0.089"	2.261	0.049"	1.245
5 mm	5, 9, 13, 20, 36, 98	0.197" ± 0.005"	5 ± 0.127	0.197" ± 0.005"	5 ± 0.127	0.065" ± 0.003"	1.651 ± 0.08	0.040"	1.016	0.098"	2.489	0.054"	1.372
6 mm	5, 9, 13, 20, 36, 98	0.236" ± 0.005"	6 ± 0.127	0.236" ± 0.005"	6 ± 0.127	0.094" ± 0.004"	2.388 ± 0.102	0.040"	1.016	0.106"	2.692	0.059"	1.499
8 mm	5, 9, 13, 20, 36, 98	0.315" ± 0.005"	8 ± 0.127	0.315" ± 0.005"	8 ± 0.127	0.094" ± 0.004"	2.388 ± 0.102	0.040"	1.016	0.117"	2.972	0.066"	1.676
10 mm	5, 9, 13, 20, 36, 98	0.394" ± 0.006"	10 ± 0.152	0.394" ± 0.006"	10 ± 0.152	0.135" ± 0.005"	3.429 ± 0.127	0.040"	1.016	0.128"	3.251	0.073"	1.854
12 mm	5, 9, 13, 20, 36, 98	0.472" ± 0.008"	12 ± 0.203	0.472" ± 0.008"	12 ± 0.203	0.135" ± 0.005"	3.429 ± 0.127	0.040"	1.016	0.138"	3.505	0.079"	2.007
18 mm	5, 9, 13, 20, 36, 98	0.709" ± 0.020"	18 ± 0.508	0.709" ± 0.020"	18 ± 0.508	0.228" ± 0.010"	5.791 ± 0.254	0.040"	1.016	0.228"	5.791	0.097"	2.464



Coefficient of thermal expansion = 11ppm/°C

Material	Temperature Coefficient of ϵ_r
05	approx. <± 5ppm/°C
09	approx. <± 5ppm/°C
13	approx. <± 5ppm/°C
20	approx. <± 5ppm/°C
36	approx. <± 5ppm/°C
98	approx. <± 15ppm/°C



Ceramic Resonators

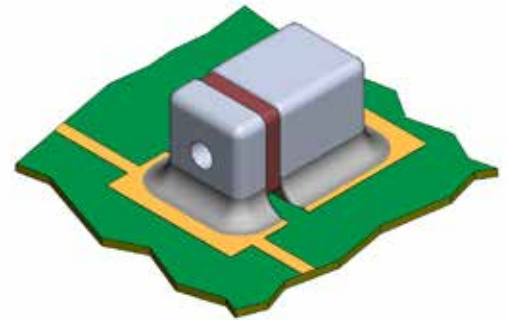
Tabless Surface Mount Coaxial Resonators



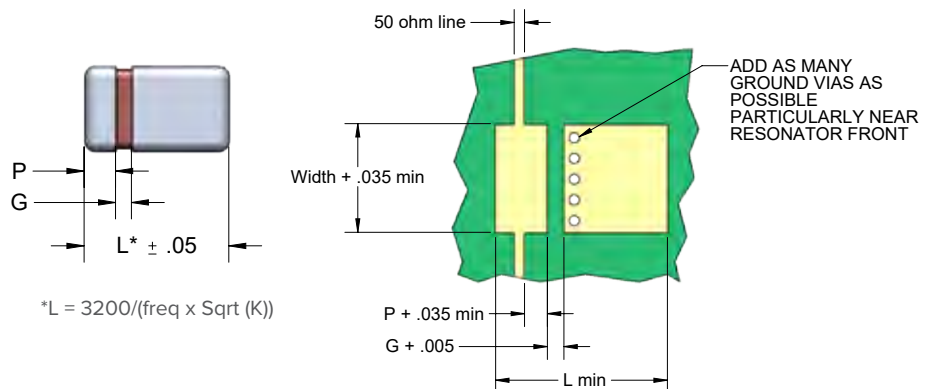
Ceramic resonators are also available in tabless configuration. This patent-pending technology represents a significant advance in reliability and accuracy, compared with traditional metal-tabbed resonators. The large solder pad eliminates misalignment and tab solder reflow problems, ensuring optimum performance.

FEATURES:

- No metal tabs
- Large solder pad
- No tab solder reflow problems
- No tab misalignment
- Higher Q



Resonator Profile	P	G
2mm	0.020"	0.025"
3mm	0.020"	0.025"
4mm	0.043"	0.050"
5mm	0.043"	0.050"
6mm	0.043"	0.050"
8mm	0.055"	0.073"
10mm	0.055"	0.073"
12mm	0.055"	0.073"
18mm	0.065"	0.090"



Part Numbering System - Example: DR03F36Q1550AYB

DR
Dielectric Coaxial Resonator

03
Dielectric Profile

F
Material Source

36
Dielectric Constant

Q
Resonator Type

1550
Frequency

A
Frequency Tolerance

Y
Tab

B
Packaging

02 mm
03 mm
04 mm
05 mm
06 mm
08 mm
10 mm
12 mm
18 mm

K5 = 05
K9 = 09
K13 = 13
K20 = 20
K36 = 36
K98 = 98

Q = Quarter Wave
H = Half Wave
P = Fully Metallized

Units in MHz

A = ±0.25%
B = ±0.50%
C = ±0.75%
D = ±1.00%
E = Special

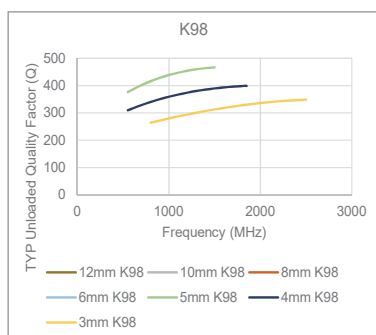
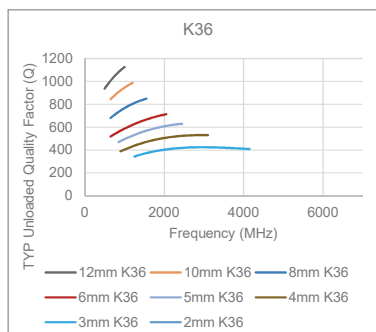
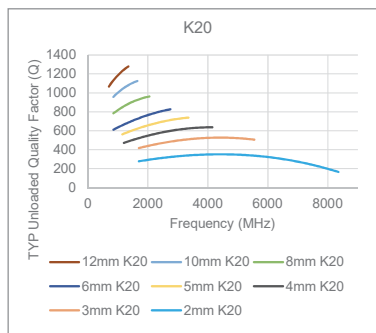
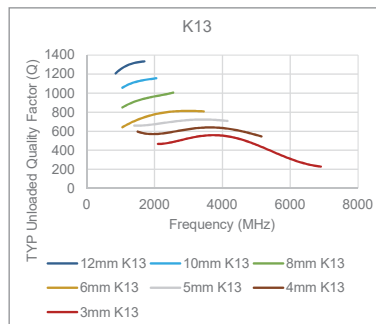
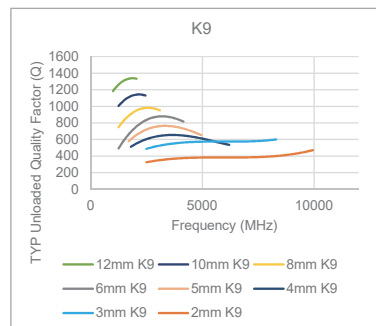
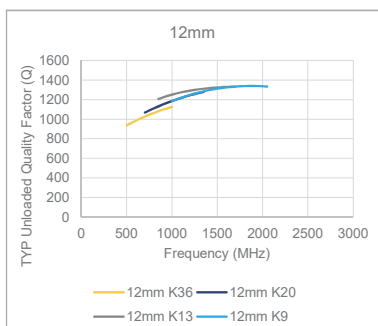
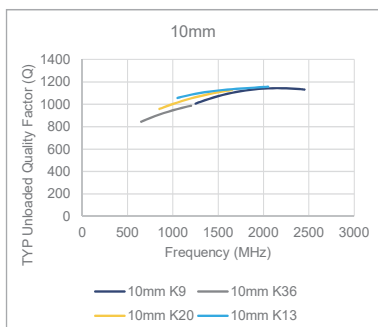
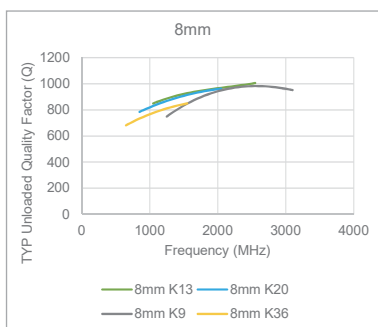
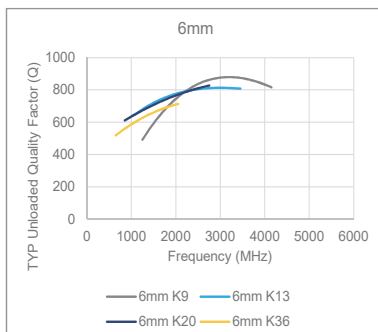
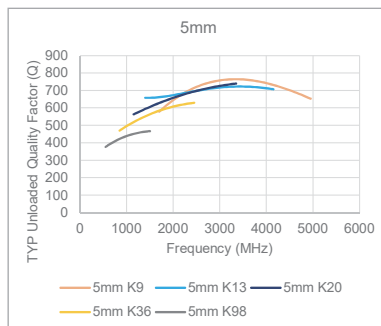
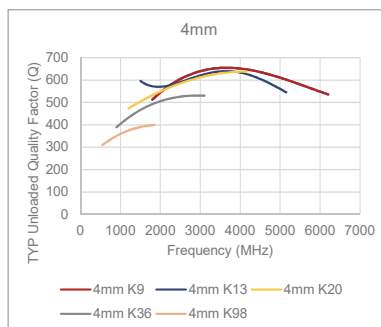
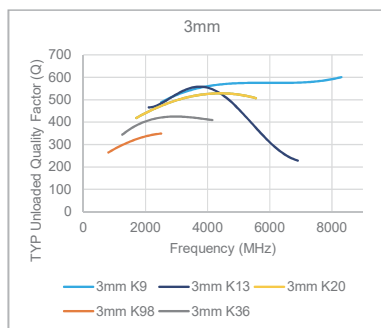
Y = Std Tab
N = No Tab
G = Tabless
Z = Tab 0.030" standoff

B = Bulk
T = Tape
S = Special



Ceramic Resonators

Q Curves



Ceramic Resonators

Frequency Range

AVAILABLE LENGTHS: MAX FREQ / MIN FREQ
DIELECTRIC MATERIAL / CONSTANT

Resonator Profile	5	9	13	20	36	98
3	9999 MHz (3mm)	8328 MHz (3mm)	6929 MHz (3mm)	5586 MHz (3mm)	4164 MHz (3mm)	2524 MHz (3mm)
	3352 MHz (10mm)	2498 MHz (10mm)	2077 MHz (10mm)	1676 MHz (10mm)	1249 MHz (10mm)	0757 MHz (10mm)
4	8379 MHz (4mm)	6246 MHz (4mm)	5197 MHz (4mm)	4190 MHz (4mm)	3123 MHz (4mm)	1893 MHz (4mm)
	2235 MHz (15mm)	1665 MHz (15mm)	1385 MHz (15mm)	1117 MHz (15mm)	0833 MHz (15mm)	0505 MHz (15mm)
5	8936 MHz (3.75mm)	6660 MHz (3.75mm)	5542 MHz (3.75mm)	4468 MHz (3.75mm)	3330 MHz (3.75mm)	2018 (3.75mm)
	2235 MHz (15mm)	1665 MHz (15mm)	1385 MHz (15mm)	1117 MHz (15mm)	0833 MHz (15mm)	0505 MHz (15mm)
6	8379 MHz (4mm)	6246 MHz (4mm)	5197 MHz (4mm)	4190 MHz (4mm)	3123 MHz (4mm)	1893 MHz (4mm)
	1457MHz (23mm)	1086MHz (23mm)	0904MHz (23mm)	0728MHz (23mm)	0543MHz (23mm)	0329MHz (23mm)
8	8379 MHz (4mm)	6246 MHz (4mm)	5197 MHz (4mm)	4190 MHz (4mm)	3123 MHz (4mm)	1893 MHz (4mm)
	1675MHz (20mm)	1249MHz (20mm)	1039MHz (20mm)	0838MHz (20mm)	0625MHz (20mm)	0378MHz (20mm)
10	6702MHz (5mm)	4995MHz (5mm)	4156MHz (5mm)	3351MHz (5mm)	2498MHz (5mm)	1514MHz (5mm)
	1523MHz (22mm)	1135MHz (22mm)	0945MHz (22mm)	0762MHz (22mm)	0568MHz (22mm)	0344MHz (22mm)
12	5585MHz (6mm)	4163MHz (6mm)	3464MHz (6mm)	2792MHz (6mm)	2081MHz (6mm)	1262MHz (6mm)
	1340MHz (25mm)	0999MHz (25mm)	0831MHz (25mm)	0670MHz (25mm)	0500MHz (25mm)	0303MHz (25mm)
18	3723MHz (9mm)	2275MHz (9mm)	2309MHz (9mm)	1862MHz (9mm)	1388MHz (9mm)	0841MHz (9mm)
	1340MHz (25mm)	0999MHz (25mm)	0831MHz (25mm)	0670MHz (25mm)	0500MHz (25mm)	0303MHz (25mm)



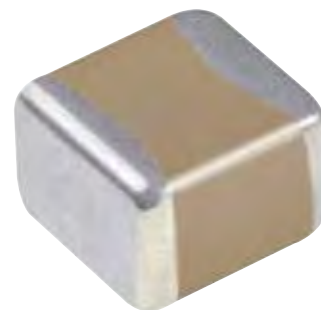
MLC – Broadband Blocks

DESCRIPTION

- Resonance free DC Blocking/Decoupling
- Less than 0.25 db loss @ 4 GHz (typical)
- Surface mountable

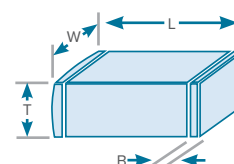
FUNCTIONAL APPLICATIONS

- Fiber Optic Links • High Isolation Decoupling • LANs, VCO Frequency Stabilization
- Diplexers • RF/Microwave Modules • Instruments • Test Equipments



MECHANICAL SPECIFICATIONS

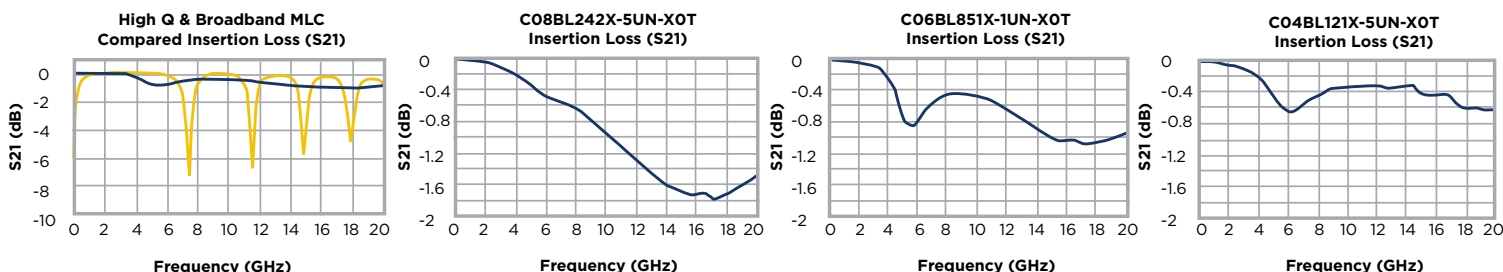
Product Code	Lengths (L)	Body Dimensions		Band Dimensions	
		Width (W)	Thickness (T)	Min	Max
C04BL	0.040" ± 0.008"	0.020" ± 0.006"	0.028" Max	0.003"	0.019"
C06BL	0.060" ± 0.012"	0.031" ± 0.009"	0.036" Max	0.006"	0.03"
C08BL	0.081" ± 0.020"	0.051" ± 0.013"	0.061" Max	0.012"	0.0468"
C18BL	0.1200" ± 0.025"	0.1100" ± 0.010"	0.100" Max	0.008"	0.045"



PART CHARACTERISTICS

Part Number	Capacitance Guaranteed Min Value	Voltage Rating	Temperature Coefficient -55°C to 125°C	Maximum Dissipation Factor	Insulation Resistance (MΩ Minimum)	Aging Rate	Frequency Range	Termination
C04BL121X-5UN-X0T	120pF @ 1KHz, 2Vrms	50 Vdc	± 15%	3.0% @ 1KHz, 2Vrms	10 ⁴	<=1.5%/decade hours	10MHz – 40GHz	"U" & "S"
C06BL851X-1UN-X0T	850pF @ 1KHz, 2Vrms	100 Vdc 50 Vdc					2MHz – 30GHz	"U", "S" & "Z"
C08BL242X-5UN-X0T	2400pF @ 1KHz, 2Vrms	50 Vdc					1MHz – 20GHz	"U", "S" & "Z"
C08BL102X-1UN-X0T	1000pF @ 1KHz, 2Vrms	100 Vdc					1MHz – 20GHz "	"U", "S" & "Z"
C18BL103X-4UN-X0T	10,000pF @ 1KHz, 2Vrms	500 Vdc					1MHz – 6GHz "	"U", "S" & "Z"

PERFORMANCE



The information above represents typical device performance.



Thin Film – Gain Equalizers

SERIES OVERVIEW

The DLI brand of gain equalizers are designed to compensate for module gain slope. Excellent repeatable microwave performance is achieved by application of precision thin-film fabrication and high-permittivity ceramic materials. This unique design solution provides near ideal R-C frequency response that is far superior to "stacked R-C chip" assemblies.



DESIGN ADVANTAGES:

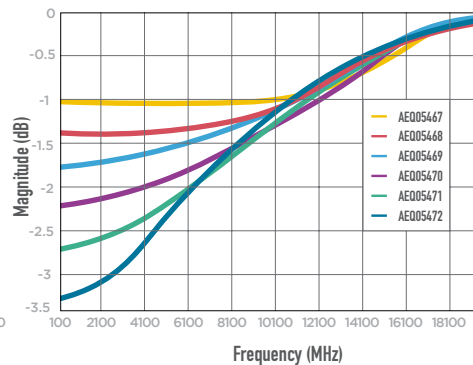
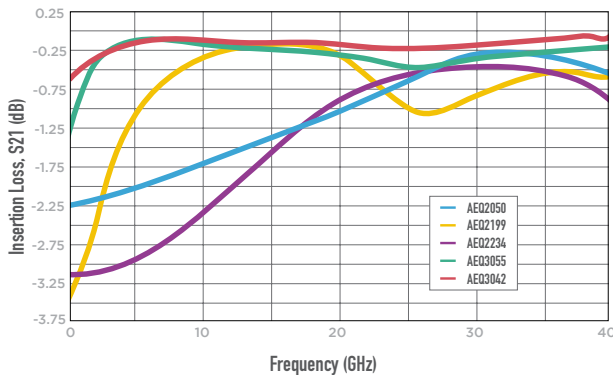
- Many designs smaller than 0402 case size
- Ease of integration
- Customization available

APPLICATIONS:

- Broadband Microwave modules: EW, ECM, ECCM
- Equalizer is utilized as a compensation circuit to correct for loss slope created by other circuit elements such as amplifiers

KEY CHARACTERISTICS:

- Superior microwave performance
- Reduced cost
- Flatten amplifier gain response
- Positive gain slope



CERTIFICATION:



ORDERING INFORMATION:

Epoxy	Solderable	Lp	Wp	G	Nominal Slope	Length	Width	Thickness
AEQ2050	AEQ05510	9 ± 1	14 ± 1	8 ± 1	2.25 dB	30 ± 2	18 ± 2	5 ± 1
AEQ2199	AEQ05246	7 ± 1		12 ± 1	3.5 dB	28 ± 2	16 ± 2	7 ± 1
AEQ2234	AEQ06042	8 ± 1	12 ± 1		3.25 dB	32 ± 1		5 ± 1
AEQ3042	AEQ3042	17.5 ± 1	17.5 ± 1	3 ± 1	0.6 dB	40 ± 2	20 ± 2	6 ± 1
AEQ3055	AEQ3055	15.4 ± 1	18.4 ± 1	7.2 ± 1	1.5 dB			
AEQ05467	AEQ05467	7 min	14 ± 1	10	1.0 dB	28 ± 1	16 ± 1	7 ± 1
AEQ05468	AEQ05468				1.5 dB			
AEQ05469	AEQ05469				2.0 dB			
AEQ05470	AEQ05470				2.5 dB			
AEQ05471	AEQ05471				3.0 dB			
AEQ05472	AEQ05472				3.5 dB			



Thin Film – Gain Equalizers

GAIN EQUALIZER KIT

Knowles understands your needs for higher performance filters in smaller, lighter packages. Our Gain Equalizers offer gain slope compensation in a single component.

Benefits include:

- Superior microwave performance
- Excellent repeatability
- Ease of assembly
- Custom designs
- Small size (0402 or smaller)
- Products up through 40GHz



	AEQ02050	AEQ02199	AEQ02234	AEQ03055	AEQ03042
Low Freq. Loss	2.2dB	3.0dB	3.5dB	1.6dB	0.8dB
Min. Loss Freq.	31.0GHz	15.0GHz	27.0GHz	5.0GHz	5.0GHz
Mounting Method	Epoxy	Epoxy	Epoxy	Solder	Solder

EW GAIN EQUALIZER KIT

Knowles understands your needs for higher performance filters in smaller, lighter packages. Our Gain Equalizers offer gain slope compensation in a single component.

Benefits include:

- Superior microwave performance
- Excellent repeatability
- Ease of assembly
- Custom designs
- Small size (0402 or smaller)
- Products up through 40GHz



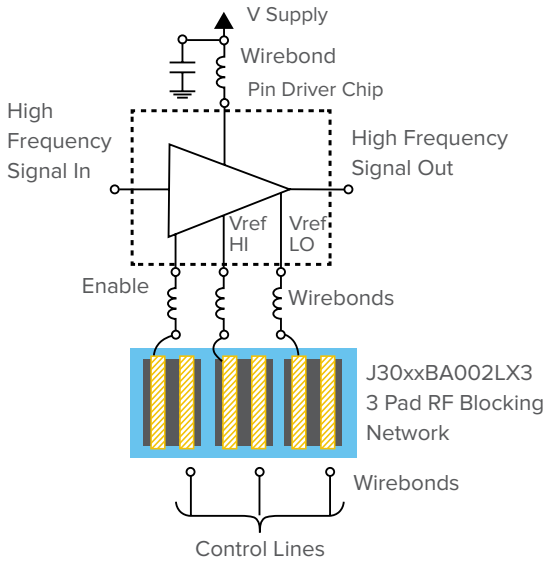
	AEQ05467	AEQ05468	AEQ05469	AEQ05470	AEQ05471	AEQ05472
Low Freq. Loss	1.0dB	1.35dB	1.75dB	2.25dB	2.75dB	3.25dB
Min. Loss Freq.	18GHz	18GHz	18GHz	18GHz	18GHz	18GHz
Mounting Method	Solder/Epoxy	Solder/Epoxy	Solder/Epoxy	Solder/Epoxy	Solder/Epoxy	Solder/Epoxy



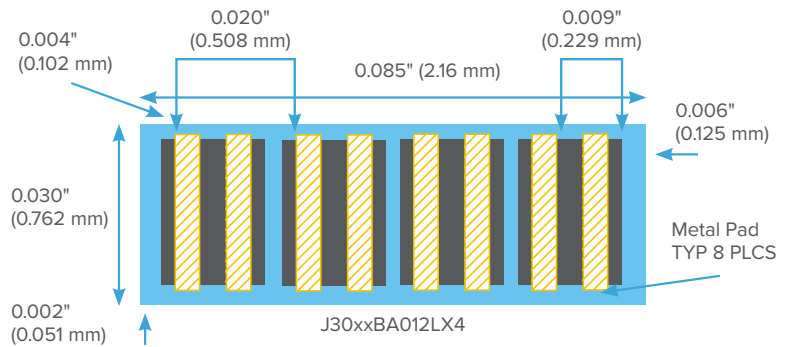
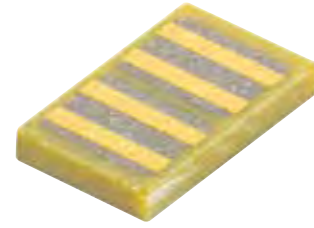
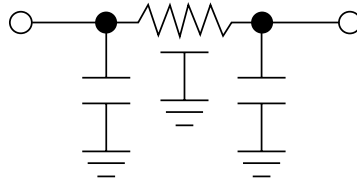
Custom Thin Film: Integrated R-C Networks

C-R-C DECOUPLING NETWORKS

(aka. RF Blocking Networks)



Segment Equivalent Schematic Representation



APPLICATIONS:

- Heatsinks and standoff
- Integrated passive components
- Custom resistor capacitor networks
- Lange couplers, power combiners
- EMI filters
- High-frequency filters
- Microwave-integrated circuits (MIC)
- Bias decoupling and filtering
- Lumped element impedance matching network
- PA stabilization
- Impedance matching and power combining network

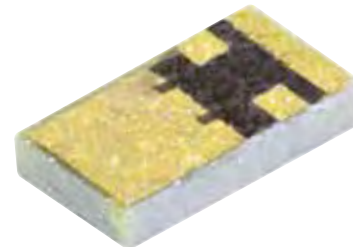
Part Number	J30BLBA032LX1	J30BLBA022LX2	J30BLBA002LX3	J30BLBA012LX4	J30BJBA032LX1	J30BJBA022LX2	J30BJBA002LX3	J30BJBA012LX4
Number of RC Segments	1	2	3	4	1	2	3	4
Nominal Resistance (pad to pad) (Ω)	10	10	10	10	10	10	10	10
Capacitance (typical) (pF)	30	30	30	30	45	45	45	45
Maximum DF	3.00%	3.00%	3.00%	3.00%	3.00%	3.00%	3.00%	3.00%
TCC	X7R	X7R	X7R	X7R	X7R	X7R	X7R	X7R
Rated Voltage (Vdc)	25	25	25	25	25	25	25	25
Attachment Method	All are configured for Chip & Wire attachment							
Termination Finish	100μinches Au, minimum							
Dimensions (inches)								
L	0.025	0.045	0.065	0.085	0.250	0.045	0.065	0.085
W	0.030	0.030	0.030	0.030	0.030	0.030	0.030	0.030
Dimensions (mm)								
L	0.64	1.14	1.65	2.16	6.35	1.14	1.65	2.16
W	0.76	0.76	0.76	0.76	0.76	0.76	0.76	0.76



Custom Thin Film: Integrated R-C Networks

BIASED FILTER NETWORK SERIES OVERVIEW

DLI bandpass filters are designed for high-performance microwave applications in a surface mountable package. Using temperature-stable, high-permittivity dielectrics and thin-film processing, these designs offer high selectivity without sacrificing in-band performance.



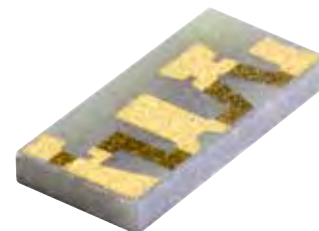
Part Number	Cap Range	Resist	Width	Length	Thickness
B20BHSBN01	40 to 90pF	100 ± 20%	.020 ± .001	.034 ± .001	.006 ± .001
B20BLSBN01	40 to 90pF	100 ± 20%	.020 ± .001	.034 ± .001	.006 ± .001
B28BHBFN01	76 to 171pF	600 ± 20%	.028 ± .001	.053 ± .001	.007 ± .001

SELF-BIASED NETWORK SERIES OVERVIEW

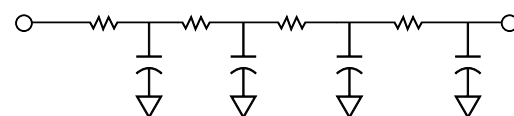
Knowles Precision Devices takes advantage of the high-permittivity ceramics offered by the DLI brand combined with thin-film resistors to provide a device that integrates source decoupling and user-selectable bias resistance.

The technique is commonly referred to as a self-biased GaAs FET amplifier – this enables the use of a single DC supply voltage. The gate is at DC ground potential and a negative V_{gs} is provided by the voltage drop across the wire bond selected resistors from source to ground – thus setting the desired drain bias current (I_{DS}).

The chip network is designed for epoxy attachment to a ground ridge, one on either side of an FET chip transistor. This provides symmetric, minimum reactance to ground source bypassing for optimum FET gain, by selectively wire bonding from resistor pads to ground. The pair of networks used for each FET provides a wide range of resistance combinations. The Self-Biased Networks, used as a pair replace two standard parallel plate capacitors and a separate set of bias resistors, reducing parts count, assembly and size.



EQUIVALENT SCHEMATIC REPRESENTATION:



Part Number	Cap Range	Resist	Width	Length	Thickness
B28BJBFN01	76 to 171pF	600 ± 20%	.028 ± .001	.053 ± .001	.007 ± .001
B28BTBFN01	112 to 168pF	600 ± 20%	.028 ± .001	.053 ± .001	.007 ± .001



Our Other Products

Air Capacitors

Discoidal Capacitors

EMI Filters

Feedthrough EMI Filters

Gain Equalizers

Half-Turn Trimmers

Hi-Cap Capacitors

Hi-Rel Products

Hi-Rel and Specialty Products

Lead Capacitors

Loaded Capacitors

Opti-Cap® Capacitors

Planar Arrays

Pulse Capacitors

Special Discrete Filters

Special Filters

Speciality Products

Stacked Chips

Trimmers

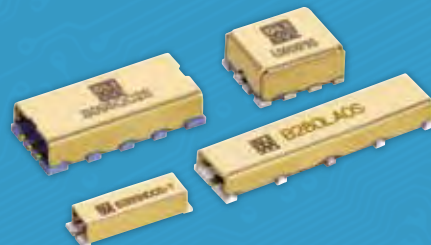
Trimmer Capacitors

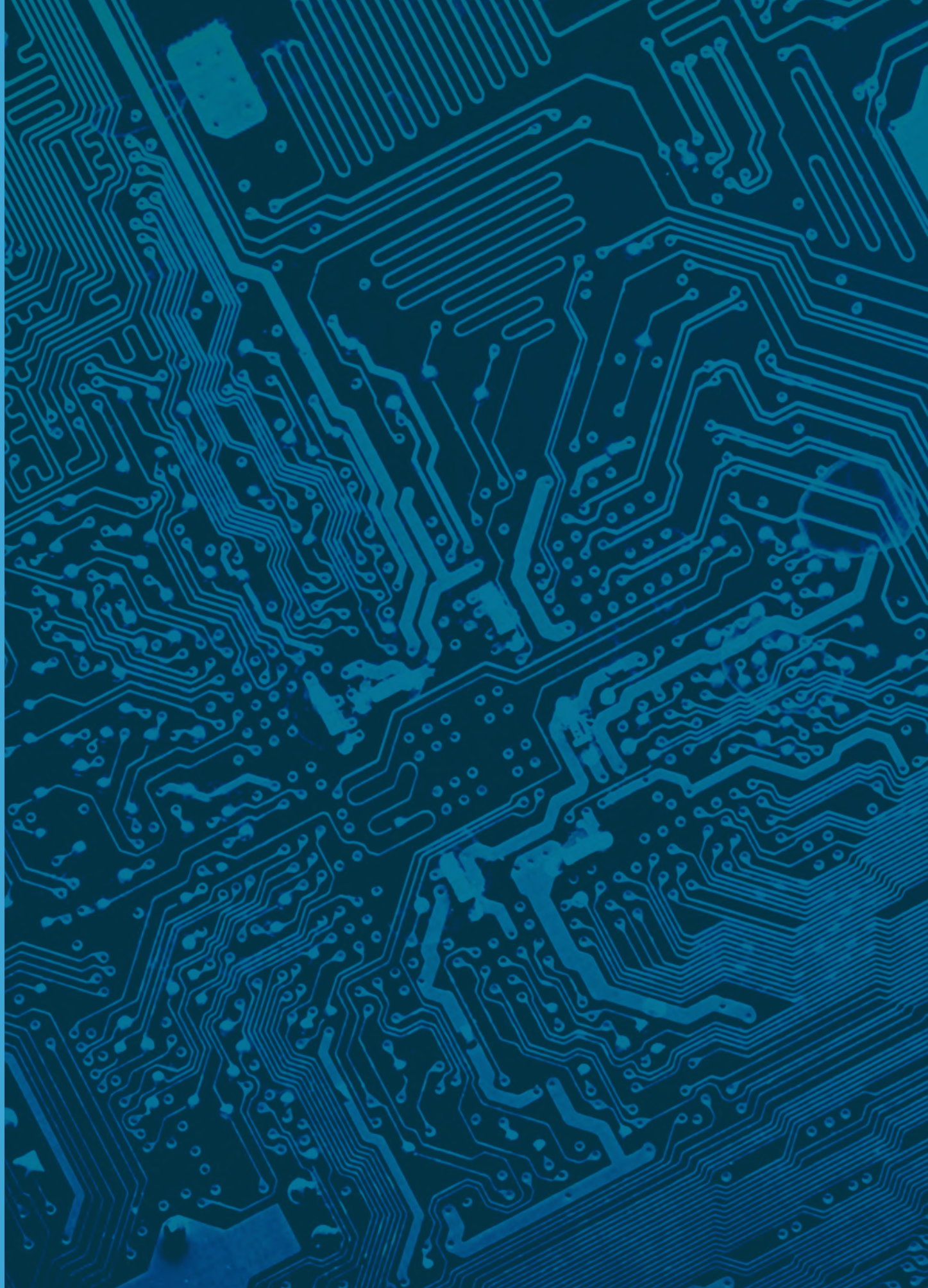
Varistor Filters

X8R Capacitors

250Vac Chips

500Vac X7R Chips





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